



# Tape & Reel Packaging Standards



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# Tape and Reel Packaging Standards

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# Tape and Reel Packaging Standards

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## In Brief . . .

This booklet has been offered to assist those looking to coordinate packaging specifications with assembly line requirements. Additionally, dimensional and ordering information is supplied for those discrete devices that take the form of axial-leaded parts.

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# Tape and Reel Packaging Standards

Embossed Tape and Reel is used to facilitate automatic pick and place equipment feed requirements. The tape is used as the shipping container for various products and requires a minimum of handling. The antistatic/conductive tape provides a secure cavity for the product when sealed with the “peel-back” cover tape.

- Two Reel Sizes Available (7” and 13”)
- Used for Automatic Pick and Place Feed Systems
- Minimizes Product Handling
- EIA 481, -1, -2 Series
- DFN/QFN covers all other Thickness Designators for these packages; i.e. WDFN, UDFN, XDFN, etc..
- 8 mm Tape: 6-Bump, 9-Bump, 10-Bump, MicroLeadless™, ChipFET, DFN/QFN packages ≤ 3.3x3.3, DSN, Flip-Chip, SOD-123, SC-59, SC-70, SC-74, SC-74A, SC-75, SC-82, SC-82AB, SC-88, SC-88A, SC-89, SOD-123, SOD-323, SOD-523, SOD-723, SOD-923, SOT-143, SOT-23, SOT-23L, SOT-323, SOT-353, SOT-553/563, SOT-723, SOT-883, SOT-1123, TSOP-5, TSOP-6, US8, WLCSP-4, WLCSP-5, XDFN2, X3DFN, XLLGA
- 12 mm Tape: DFN/QFN packages > 3.3x3.3 and ≤ 7x7, FCBGA-16, Micro10, Micro8™, PowerFLEX™, POWERMITE™, QSOP-16, SMA, SMB, SO-8 (SOIC 8), SOT-223, SOT-89, SSOP-8, TSSOP-8, TSSOP-10, TSSOP-14, TSSOP-16
- 16 mm Tape: DFN/QFN packages > 7x7, DPAK, FCBGA-16, PLCC-20, QSOP-24, SMC, SO-14 (SOIC 14), SO-16 (SOIC 16), SO-16 Wide (SOIC 16W), SOIC-EIAJ8, SOIC-EIAJ14, SOIC-EIAJ16, SOP-16, SSOP-14 Wide, SSOP36-EP, TQFP-32, TSSOP-20
- 24 mm Tape: D<sup>2</sup>PAK, FCBGA-81, LQFP-52, LQFP-64, PLCC-28, SO-18 Wide (SOIC 18W), SO-20 Wide (SOIC 20W), SO-24 Wide (SOIC 24W), SOEIAJ-20, SSOP36-EP (Non-standard), TQFP-52, TQFP-64, TSSOP-48
- 32 mm Tape: PLCC-44, PLCC-52, SO-28L Wide (SOIC 28W), SO-28 Wide (SOIC 28W), SO-32 Wide (SOIC 32W),
- 44 mm Tape: PLCC-98, PLCC-84
- For Leadless Package Pin 1 Orientation, please see Figure 41 (Effective January 2007).

Use the standard device title and add the required suffix as listed in the option table on the following page. Note that the individual reels have a finite number of devices depending on the type of product contained in the tape. Also note the minimum lot size is one full reel for each line item, and orders are required to be in increments of the single reel quantity.

## Embossed Tape and Reel Ordering Information

| Package                               | Tape Width mm   | Pitch mm<br>(Dimension P <sub>1</sub> )<br>(inch) | Reel Size |      | Devices Per Reel and Min Order Quantity | Tape and Reel Suffix                 | Fig No | Page No |
|---------------------------------------|---|---|-----------|------|---|--------------------------------------|--------|---------|
|                                       |   |   | (mm)      | (in) |   |                                      |        |         |
| 6-Bump<br>(1.489x0.989)               | 8   | 4.0 ± 0.1 (0.158 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – TMOS                            | 7      | 14      |
| 9-Bump<br>(1.489x1.489)               | 8   | 4.0 ± 0.1 (0.158 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – TMOS                            | 7      | 14      |
| 10-Bump                               | 8   | 4.0 ± 0.1 (0.158 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                        | 7      | 14      |
| Axial Leaded                          | See Axial Leaded package standards beginning on page 28 |   |           |      |   |                                      |        |         |
| ChipFET                               | 8   | 4.0 ± 0.1 (0.158 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – TMOS                            | 11     | 15      |
| D <sup>2</sup> PAK 3 Lead             | 24  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 800                                     | R4 Analog<br>T4 – Discrete           | 1      | 13      |
| D <sup>2</sup> PAK 5 Lead             | 24  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 800                                     | R4 – Analog<br>T4 – Discrete         | 1      | 13      |
| D <sup>2</sup> PAK 7 Lead             | 24  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 750                                     | R7 – Analog                          | 1      | 13      |
| DFN/QFN ≤<br>1.2x1.6x0.9              | 8   | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 8000                                    | N/A                                  | 38     | 19      |
| DFN/QFN ≤<br>1.4x1.4mm                | 8   | 2.0 ± 0.1 (0.079 ± 0.004)                         | 178       | 7    | See Data Sheet                          | Various                              | 38–41  | 19,20   |
| DFN/QFN ≤<br>3.3x3.3mm                | 8   | 4.0 ± 0.1 (0.158 ± 0.004)                         | 178       | 7    | See Data Sheet                          | See Data Sheet                       | 38–41  | 19,20   |
|                                       | 8   | 4.0 ± 0.1 (0.158 ± 0.004)                         | 330       | 13   | See Data Sheet                          | See Data Sheet                       |        |         |
| DFN/QFN ≥<br>3.0x3.0mm and ≤<br>7x7mm | 12  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 178       | 7    | See Data Sheet                          | See Data Sheet                       | 38–41  | 19,20   |
|                                       | 12  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | See Data Sheet                          | See Data Sheet                       |        |         |
| DFN/QFN<br>7x7mm                      | 12  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 178       | 7    | See Data Sheet                          | See Data Sheet                       | 38–41  | 19,20   |
|                                       | 12  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | See Data Sheet                          | See Data Sheet                       |        |         |
| DFN/QFN<br>9x9mm                      | 16  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 178       | 7    | See Data Sheet                          | See Data Sheet                       | 38–41  | 19,20   |
|                                       | 16  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | See Data Sheet                          | See Data Sheet                       |        |         |
| DFN/QFN<br>10x10mm                    | 16  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 178       | 7    | See Data Sheet                          | See Data Sheet                       | 38–41  | 19,20   |
|                                       | 16  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | See Data Sheet                          | See Data Sheet                       |        |         |
| DFN/QFN<br>10.5x10.5mm                | 16  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 178       | 7    | See Data Sheet                          | See Data Sheet                       | 38–41  | 19,20   |
|                                       | 16  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | See Data Sheet                          | See Data Sheet                       |        |         |
| DO–41                                 | 79  | 5.08 ± 0.508                                      | 356       | 14   | 5,000                                   | RL – Discrete                        | N/A    | 33      |
| DPAK                                  | 16  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 1,800                                   | RL – Discrete                        | 4      | 13      |
| DPAK                                  | 16  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500                                   | T4, T5 – Discrete<br>RK, T5 – Analog | 2, 3   | 13      |
| DSN                                   | 8   | 2.0 ± 0.05 (0.079 ± 0.002)                        | 178       | 7    | 5,000                                   | T5 – Discrete                        | 6      | 14      |
| FCBGA–16                              | 12  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500/500                               | R2 – Clock & Data Mgmt               | 37     | 19      |
| FCBGA–49                              | 16  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 2,000/500                               | R2 – Clock & Data Mgmt               | 37     | 19      |
| FCBGA–81                              | 24  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 1,500/500                               | R2 – Clock & Data Mgmt               | 37     | 19      |
| Flip–Chip                             | 8   | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                        | N/A    | N/A     |
| LGA17 5.97x3.43                       | 12  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 178       | 7    | 250                                     | XTP                                  | 46     | 27      |
| LQFP – 48                             | 16  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 2,000                                   | R48 – Analog                         | 8      | 14      |
| LQFP–32                               | 16  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 1800 or 2000                            | R2 – Analog, Clock &<br>Data Mgmt    | 8      | 14      |
| LQFP–52                               | 24  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 1,500                                   | R2 – Clock & Data Mgmt               | 8      | 14      |
| LQFP–64                               | 24  | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 1,500                                   | R2 – Clock & Data Mgmt               | 8      | 14      |
| Micro10                               | 12  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 4,000                                   | R2 – Analog, Discrete                | 33     | 18      |
| Micro8™                               | 12  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500                                   | R2, T – Analog                       | 33     | 18      |
| Micro8                                | 12  | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 4,000                                   | R2 – Analog, Discrete                | 33     | 18      |

## Embossed Tape and Reel Ordering Information

| Package         | Tape Width mm | Pitch mm<br>(Dimension P <sub>1</sub> )<br>(inch) | Reel Size |      | Devices Per Reel and Min Order Quantity | Tape and Reel Suffix             | Fig No | Page No |
|-----------------|---------------|---|-----------|------|---|----------------------------------|--------|---------|
|                 |               |   | (mm)      | (in) |   |                                  |        |         |
| PLCC-20         | 16            | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 1,000                                   | R2 – Clock & Data Mgmt           | 9      | 14      |
| PLCC-28         | 24            | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 500                                     | R2 – Clock & Data Mgmt           | 9      | 14      |
| PLCC-44         | 32            | 24.0 ± 0.1 (0.942 ± 0.004)                        | 330       | 13   | 500                                     | R2 – Clock & Data Mgmt, Analog   | 9      | 14      |
| PLCC-44         | 32            | 24.0 ± 0.1 (0.942 ± 0.004)                        | 330       | 13   | 500                                     | R44 – Analog                     | 9      | 14      |
| PLCC-52         | 32            | 24.0 ± 0.1 (0.942 ± 0.004)                        | 330       | 13   | 500                                     | R2 – Clock & Data Mgmt, Analog   | 9      | 14      |
| PLCC-68         | 44            | 32.0 ± 0.1 (1.256 ± 0.004)                        | 330       | 13   | 250                                     | R2 – Clock & Data Mgmt, Analog   | 9      | 14      |
| PLCC-84         | 44            | 36.0 ± 0.1 (1.418 ± 0.004)                        | 330       | 13   | 250                                     | R2 – Clock & Data Mgmt, Analog   | 9      | 14      |
| PowerFLEX™      | 12            | 24.0 ± 0.1 (0.942 ± 0.004)                        | 330       | 13   | 2,000                                   | R7 – Analog                      | 1      | 13      |
| POWERMITE®      | 12            | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, TR7 – Discrete               | 20     | 16      |
| POWERMITE       | 12            | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 12,000                                  | T3, TR13 – Discrete              | 20     | 16      |
| SC-59           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, T2 – Discrete                | 13     | 15      |
| SC-59           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3 – Discrete                    | 13     | 15      |
| SC-70           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                    | 13     | 15      |
| SC-70           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3 – Discrete                    | 13     | 15      |
| SC-70 5 Lead    | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Analog                      | 15     | 15      |
| SC-70 6 Lead    | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Analog                      | 22     | 17      |
| SC-70 6 Lead    | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3 – Analog                      | 22     | 17      |
| SC-74           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                    | 14     | 15      |
| SC-74A          | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                    | 12     | 15      |
| SC-75           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                    | 13     | 15      |
| SC-82           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | TR – Analog                      | 10     | 15      |
| SC-82AB         | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Analog, Discrete            | 10     | 15      |
| SC-88           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3 – Discrete                    | 22     | 17      |
| SC-88           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, T2 – Discrete<br>T1 – Analog | 22     | 17      |
| SC-88A          | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, T2 – Discrete                | 15     | 15      |
| SC-88A          | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3, T4 – Discrete                | 15     | 15      |
| SC-89           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                    | 13     | 15      |
| SC-89           | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3 – Discrete                    | 13     | 15      |
| SIP21 3.10x5.08 | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                         | 178       | 7    | 250                                     | T                                | 46     | 27      |
| SIP33 3.10x4.75 | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                         | 178       | 7    | 250                                     |                                  | 46     | 27      |
| SMA             | 12            | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 1,500                                   | T1 – Discrete                    | 21     | 16      |
| SMA             | 12            | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 5,000                                   | T3 – Discrete                    | 21     | 16      |
| SMB             | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                         | 178       | 7    | 1,000                                   | T1 – Discrete                    | 21     | 16      |
| SMB             | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500                                   | T3 – Discrete                    | 21     | 16      |
| SMC             | 16            | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500                                   | T3 – Discrete                    | 21     | 16      |
| SO-8 (SOIC 8)   | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500 / 3,000                           | R8 – Analog E.G.*                | 33     | 18      |

|                        |    |                            |     |    |               |                                       |     |     |
|------------------------|----|----------------------------|-----|----|---------------|---------------------------------------|-----|-----|
| SO-8 (SOIC 8)          | 12 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 2,500 / 3,000 | R2 – TMOS, Analog, Clock & Data Mgmt  | 33  | 18  |
| SO-8 (SOIC 8)          | 12 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 2,500 / 3,000 | T3 – EEPROM                           | 33  | 18  |
| SO-10 (SOIC 10)        | 12 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 2,500         | R2 – Analog                           | 33  | 18  |
| SO-14 (SOIC 14)        | 16 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 3,000         | R14 – Analog E.G.*                    | 33  | 18  |
| SO-14 (SOIC 14)        | 16 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 3,000         | R2 – Clock & Data Mgmt, Logic, Analog | 33  | 18  |
| SO-16 (SOIC 16)        | 16 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 3,000         | R2 – Clock & Data Mgmt, Logic, Analog | 33  | 18  |
| SO-16 (SOIC 16)        | 16 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 3,000         | R16 – Analog E.G.*                    | 33  | 18  |
| SO-16 Wide (SOIC 16W)  | 16 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 1,500         | R2 – Clock & Data Mgmt, Logic, Analog | 33  | 18  |
| SO-16 Wide (SOIC 16W)  | 16 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 1,500         | R16 – Analog E.G.*                    | 33  | 18  |
| SO-18 Wide (SOIC 18W)  | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,000         | R2 – Clock & Data Mgmt                | 33  | 18  |
| SO-18 Wide (SOIC 18W)  | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,000         | R18 – Analog E.G.*                    | 33  | 18  |
| SO-20 Wide (SOIC 20W)  | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,500         | R2 – Analog, Clock & Data Mgmt        | 33  | 18  |
| SO-20 Wide (SOIC 20W)  | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,500         | R20 – Analog E.G.*                    | 33  | 18  |
| SO-24 Wide (SOIC 24W)  | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,500         | R2 – Analog, Clock & Data Mgmt        | 33  | 18  |
| SO-24 Wide (SOIC 24W)  | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,500         | R24 – Analog E.G.*                    | 33  | 18  |
| SO-28 Wide (SOIC 28W)  | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,000         | R2 – Analog, Clock & Data Mgmt        | 34  | 18  |
| SO-28L Wide (SOIC 28W) | 32 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,000         | R3 – Analog                           | 34  | 18  |
| SO-28 Wide (SOIC 28W)  | 32 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,000         | R28– Analog E.G.*                     | 34  | 18  |
| SO-32 Wide (SOIC 32W)  | 32 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 1,000         | R32– Analog E.G.*                     | 33  | 18  |
| SOIC-EIAJ8             | 16 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 2,000         | T2 – EEPROM                           | 33  | 18  |
| SOIC-EIAJ14            | 16 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 2,000         | EL – Logic                            | 33  | 18  |
| SOIC-EIAJ16            | 16 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 2,000         | EL – Logic                            | 33  | 18  |
| SOIC-EIAJ20            | 24 | 12.0 ± 0.1 (0.471 ± 0.004) | 330 | 13 | 2,000         | EL – Logic                            | 33  | 18  |
| SOD-123                | 8  | 4.0 ± 0.1 (0.157 ± 0.004)  | 178 | 7  | 3,000         | T1, T2 – Discrete                     | 26  | 17  |
| SOD-123                | 8  | 4.0 ± 0.1 (0.157 ± 0.004)  | 330 | 13 | 10,000        | T3 – Discrete                         | 26  | 17  |
| SOD-323                | 8  | 4.0 ± 0.1 (0.157 ± 0.004)  | 178 | 7  | 3,000         | T1 – Discrete                         | 26  | 17  |
| SOD-323                | 8  | 4.0 ± 0.1 (0.157 ± 0.004)  | 330 | 13 | 10,000        | T3 – Discrete                         | 26  | 17  |
| SOD-523                | 8  | 4.0 ± 0.1 (0.157 ± 0.004)  | 178 | 7  | 3,000         | T1 – Discrete                         | 29  | 18  |
| SOD-523                | 8  | 2.0 ± 0.05 (0.079 ± 0.002) | 178 | 7  | 8,000         | T5 – Discrete                         | 29  | 18  |
| SOD-723                | 8  | 2.0 ± 0.05 (0.079 ± 0.002) | 178 | 7  | 8,000         | T5 – Discrete                         | 30  | 18  |
| SOD-923                | 8  | 2.0 ± 0.05 (0.079 ± 0.002) | 178 | 7  | 8,000         | T5 – Discrete                         | 30  | 18  |
| SON-6                  | 8  | 4.0 ± 0.1 (0.157 ± 0.004)  | 178 | 7  | 3,000         | T1 – Analog                           | 27  | 17  |
| SON-8                  | 8  | 4.0 ± 0.1 (0.157 ± 0.004)  | 178 | 7  | 3,000         | T1 – Analog                           | N/A | N/A |
| SOP-16                 | 16 | 8.0 ± 0.1 (0.315 ± 0.004)  | 330 | 13 | 2,500         | R2 – Analog                           | 33  | 18  |

\* Applies to Analog devices manufactured at the East Greenwich, Rhode Island, USA facility.



## Embossed Tape and Reel Ordering Information

| Package       | Tape Width mm  | Pitch mm<br>(Dimension P <sub>1</sub> )<br>(inch) | Reel Size |      | Devices Per Reel and Min Order Quantity | Tape and Reel Suffix               | Fig No | Page No |
|---------------|--|---|-----------|------|---|------------------------------------|--------|---------|
|               |  |   | (mm)      | (in) |   |                                    |        |         |
| SOT-143       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3, T4 – Discrete                  | 25     | 17      |
| SOT-143       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, T2, Discrete<br>T – Analog     | 25     | 17      |
| SOT-223       | 12   | 8.0 ± 0.1 (0.315 ± 0.004)                         | 178       | 7    | 1,000                                   | T1 – Discrete, Analog              | 31     | 18      |
| SOT-223       | 12   | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500                                   | R3 or T3 – Analog E.G.*            | 31     | 18      |
| SOT-223       | 12   | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 4,000                                   | T3 – Discrete, TMOS<br>T3 – Analog | 31     | 18      |
| SOT-23        | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, – Discrete<br>TR, T1 – Analog  | 13     | 15      |
| SOT-23        | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3 – Discrete                      | 13     | 15      |
| SOT-23 5 Lead | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, TR, T – Analog                 | 12     | 15      |
| SOT-23 6 Lead | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, R1 – Analog                    | 14     | 15      |
| SOT-23L       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 4,000                                   | R2 – Analog                        | 13     | 15      |
| SOT-323       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1 – Discrete                      | 13     | 15      |
| SOT-323       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3 – Discrete                      | 13     | 15      |
| SOT-353       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 3,000                                   | T1, T2 – Discrete                  | 15     | 15      |
| SOT-353       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 330       | 13   | 10,000                                  | T3, T4 – Discrete                  | 15     | 15      |
| SOT-553/563   | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 4,000                                   | T1 – Discrete, Logic               | 16,17  | 16      |
| SOT-553/563   | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 4,000                                   | T2 – Discrete, Logic,<br>Analog    | 16,17  | 16      |
| SOT-553/563   | 8  | 2.0 ± 0.05 (0.079 ± 0.002)                        | 178       | 7    | 8,000                                   | T5 – Discrete, Logic               | 16,17  | 16      |
| SOT-553/563   | 8  | 2.0 ± 0.05 (0.079 ± 0.002)                        | 178       | 7    | 8,000                                   | T6 – Discrete, Logic               | 16,17  | 16      |
| SOT-723       | 8  | 4.0 ± 0.1 (0.157 ± 0.004)                         | 178       | 7    | 4,000                                   | T1 – Discrete                      | 32     | 18      |
| SOT-723       | 8  | 2.0 ± 0.05 (0.079 ± 0.002)                        | 178       | 7    | 8,000                                   | T5 – Discrete                      | 32     | 18      |
| SOT-89        | 12   | 8.0 ± 0.1 (0.315 ± 0.004)                         | 178       | 7    | 1,000                                   | T1, R1 – Discrete                  | 23     | 17      |
|               | 12   | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 2,500                                   | T1 – Analog                        |        |         |
| SOT-883       | 8  | 2.0 ± 0.1 (0.158 ± 0.004)                         | 178       | 7    | 8,000                                   | T5 – Discrete                      | 5      | 14      |
| SOT-953/963   | 8  | 2.0 ± 0.05 (0.079 ± 0.002)                        | 178       | 7    | 8,000                                   | T5 – Discrete, Logic               | 18,19  | 16      |
| SOT-1123      | 8  | 2.0 ± 0.1 (0.158 ± 0.004)                         | 178       | 7    | 8,000                                   | T5 – Discrete                      | 28     | 17      |
| SSOP-8        | 12   | 8.0 ± 0.1 (0.315 ± 0.004)                         | 330       | 13   | 3,000                                   | T1 – Analog                        | 33     | 18      |
| SSOP-14       | 16   | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 2,000                                   | R14 – Analog E.G.*                 | 33     | 18      |
| SSOP-16       | 16   | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 2,000                                   | R16 – Analog E.G.*                 | 33     | 18      |
| SSOP-20       | 16   | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 2,000                                   | R20 – Analog E.G.*                 | 33     | 18      |
| SSOP-24 Wide  | 16   | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 2,000                                   | R24 – Analog E.G.*                 | 33     | 18      |
| SSOP-36 EP    | 16   | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 1,500                                   | R2 – Analog                        | 33     | 18      |
| SSOP-36 EP    | 24*  | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 1,500                                   | R2 – Analog<br>(*Non-standard)     | 33     | 18      |
| TO-92         | See TO-92 and other Axial Leaded package specifications beginning on page 28 |   |           |      |   |                                    |        |         |
| TQFP-32       | 16   | 12.0 ± 0.1 (0.471 ± 0.004)                        | 330       | 13   | 2,000                                   | R2 – Analog, Clock &<br>Data Mgmt  | 8      | 14      |
| TQFP-52       | 24   | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 1,500                                   | R2 – Clock & Data Mgmt             | 8      | 14      |
| TQFP-64       | 24   | 16.0 ± 0.1 (0.630 ± 0.004)                        | 330       | 13   | 1,500                                   | R2 – Clock & Data Mgmt             | 8      | 14      |

\* Applies to Analog devices manufactured at the East Greenwich, Rhode Island, USA facility.

## Embossed Tape and Reel Ordering Information

| Package                               | Tape Width mm | Pitch mm<br>(Dimension P <sub>1</sub> )<br>(inch)        | Reel Size  |         | Devices Per Reel and Min Order Quantity | Tape and Reel Suffix                     | Fig No | Page No |
|---------------------------------------|---------------|--|------------|---------|---|--|--------|---------|
|                                       |               |  | (mm)       | (in)    |   |  |        |         |
| TSOP-5                                | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 3,000                                   | T1, T2 – Discrete<br>T1, T2, TR – Analog | 12     | 15      |
| TSOP-5                                | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 330        | 13      | 10,000                                  | T3 – Discrete                            | 12     | 15      |
| TSOP-6                                | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 3,000                                   | T1, T2 – Analog, Discrete                | 14     | 15      |
| TSOP-6                                | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 330        | 13      | 10,000                                  | T3 – Analog, Discrete                    | 14     | 15      |
| TSSOP-10                              | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 2,500                                   | R2 – Clock & Data Mgmt                   | 33     | 18      |
| TSSOP-14                              | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 2,500                                   | R2 – Analog, Clock & Data Mgmt           | 33     | 18      |
| TSSOP-16                              | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 2,500                                   | R2 – Analog, Clock & Data Mgmt           | 33     | 18      |
| TSSOP-20                              | 16            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 2,500                                   | R2 – Analog, Clock & Data Mgmt           | 33     | 18      |
| TSSOP-24                              | 16            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 2,500                                   | R2 – Analog, Clock & Data Mgmt           | 33     | 18      |
| TSSOP-48                              | 24            | 12.0 ± 0.1 (0.471 ± 0.004)                               | 330        | 13      | 2,500                                   | R2 – Clock & Data Mgmt                   | 33     | 18      |
| TSSOP-8                               | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 2,500                                   | R2 – Analog, Clock & Data Mgmt           | 33     | 18      |
| TSSOP-8                               | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 4,000                                   | R2 – Discrete, MOS                       | 33     | 18      |
| TSSOP-8                               | 12            | 8.0 ± 0.1 (0.315 ± 0.004)                                | 330        | 13      | 3,000                                   | R3 – Discrete, MOS                       | 33     | 18      |
| US8                                   | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 3,000                                   | US – Logic                               | 24     | 17      |
| WLCSP 8-Bump<br>0.652x0.834mm         | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 4000                                    | N/A                                      | 40     | 19      |
| WLCSP 12-Bump<br>0.652x1.134mm        | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 4000                                    | N/A                                      | 40     | 19      |
| WLCSP 8-Bump<br>0.722x0.879mm         | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 4000                                    | N/A                                      | 40     | 19      |
| WLCSP 10-Bump<br>0.722x1.029mm        | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 4000                                    | N/A                                      | 40     | 19      |
| WLCSP 12-Bump<br>0.722x1.179mm        | 8             | 4.0 ± 0.1 (0.157 ± 0.004)                                | 178        | 7       | 4000                                    | N/A                                      | 40     | 19      |
| WLCSP ≤<br>0.86x0.84mm                | 8             | 2.0 ± 0.1 (0.079 ± 0.004)                                | 178        | 7       | 5000                                    | TR                                       | 38-41  | 19,20   |
| WLCSP ≤<br>1.4x1.4mm                  | 8             | 2.0 ± 0.1 (0.079 ± 0.004)                                | 178        | 7       | See Data Sheet                          | Various                                  | 38-41  | 19,20   |
| WLCSP ≤<br>3.3x3.3mm                  | 8<br>8        | 4.0 ± 0.1 (0.158 ± 0.004)<br>4.0 ± 0.1 (0.158 ± 0.004)   | 178<br>330 | 7<br>13 | See Data Sheet<br>See Data Sheet        | Various<br>Various                       | 38-41  | 19,20   |
| WLCSP ><br>3.3x3.3mm and ≤<br>7x7mm   | 12<br>12      | 8.0 ± 0.1 (0.315 ± 0.004)<br>8.0 ± 0.1 (0.315 ± 0.004)   | 178<br>330 | 7<br>13 | See Data Sheet<br>See Data Sheet        | Various<br>Various                       | 38-41  | 19,20   |
| WLCSP ><br>7x7mm and ≤<br>8x8mm       | 12<br>12      | 16.0 ± 0.1 (0.630 ± 0.004)<br>16.0 ± 0.1 (0.630 ± 0.004) | 178<br>330 | 7<br>13 | See Data Sheet<br>See Data Sheet        | Various<br>Various                       | 38-41  | 19,20   |
| WLCSP > 8x8mm<br>and ≤<br>10.5x10.5mm | 16<br>16      | 12.0 ± 0.1 (0.471 ± 0.004)<br>12.0 ± 0.1 (0.471 ± 0.004) | 178<br>330 | 7<br>13 | See Data Sheet<br>See Data Sheet        | Various<br>Various                       | 38-41  | 19,20   |
| WLCSP<br>>10.5x10.5mm                 | 16<br>16      | 16.0 ± 0.1 (0.630 ± 0.004)<br>16.0 ± 0.1 (0.630 ± 0.004) | 178<br>330 | 7<br>13 | See Data Sheet<br>See Data Sheet        | Various<br>Various                       | 38-41  | 19,20   |
| XDFN2                                 | 8             | 2.0 ± 0.1 (0.158 ± 0.004)                                | 178        | 7       | 8,000                                   | T5 – Discrete                            | 5      | 14      |
| XLLGA                                 | 8             | 2.0 ± 0.1 (0.158 ± 0.004)                                | 178        | 7       | 8,000                                   | T5 – Discrete                            | 36     | 19      |

\* Applies to Analog devices manufactured at the East Greenwich, Rhode Island, USA facility.

# Former CMD Tape & Reel Standards, by Package

Former CMD Tape and Reel Standards by Package

| Package      | Package Size (mm)     | Tape Width | Reel Diameter | Quantity per Reel | P <sub>0</sub> | P <sub>1</sub> | Orientation Quadrant |
|--------------|-----------------------|------------|---------------|-------------------|----------------|----------------|----------------------|
| CSP, 2-Bump  | 0.60 x 0.30 x 0.275   | 8 mm       | 178 mm (7")   | 15,000            | 4 mm           | 4 mm           | Top                  |
| CSP, 4-Bump  | 0.8 x 0.8 x 0.50      | 8 mm       | 178 mm (7")   | 10,000            | 4 mm           | 2 mm           | B                    |
| CSP, 4-Bump  | 0.8 x 0.8 x 0.60      | 8 mm       | 178 mm (7")   | 5000              | 4 mm           | 4 mm           | B                    |
| CSP, 4-Bump  | 0.96 x 0.96 x 0.644   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 4-Bump  | 0.96 x 0.96 x 0.65    | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 5-Bump  | 1.05 x 0.76 x 0.615   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 5-Bump  | 1.20 x 0.80 x 0.60    | 8 mm       | 178 mm (7")   | 5000              | 4 mm           | 4 mm           | B                    |
| CSP, 5-Bump  | 1.33 x 0.96 x 0.606   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | A                    |
| CSP, 5-Bump  | 1.33 x 0.96 x 0.644   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | A                    |
| CSP, 5-Bump  | 1.41 x 0.93 x 0.606   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | A                    |
| CSP, 5-Bump  | 1.41 x 0.95 x 0.644   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | A                    |
| CSP, 5-Bump  | 1.59 x 1.22 x 0.64    | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 6-Bump  | 1.46 x 0.96 x 0.644   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 6-Bump  | 1.72 x 1.22 x 0.64    | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 6-Bump  | 1.804 x 1.154 x 0.644 | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 8-Bump  | 1.16 x 1.16 x 0.60    | 8 mm       | 178 mm (7")   | 5000              | 4 mm           | 4 mm           | B                    |
| CSP, 8-Bump  | 1.20 x 1.20 x 0.60    | 8 mm       | 178 mm (7")   | 5000              | 4 mm           | 4 mm           | B                    |
| CSP, 8-Bump  | 1.43 x 1.41 x 0.605   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 8-Bump  | 1.60 x 1.60 x 0.65    | 8 mm       | 178 mm (7")   | 5000              | 4 mm           | 4 mm           | B                    |
| CSP, 9-bump  | 2.470 x 0.970 x 0.606 | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 9-bump  | 2.470 x 0.970 x 0.644 | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 10-Bump | 1.56 x 1.053 x 0.615  | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 10-Bump | 1.67 x 1.11 x 0.615   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 10-Bump | 1.67 x 1.14 x 0.615   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 10-Bump | 1.96 x 1.33 x 0.606   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 10-Bump | 1.96 x 1.33 x 0.644   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | A                    |
| CSP, 10-Bump | 2.46 x 0.96 x 0.644   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 10-Bump | 3.104 x 1.154 x 0.682 | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 11-Bump | 1.46 x 1.96 x 0.65    | 8 mm       | 178 mm (7")   | 5000              | 4 mm           | 4 mm           | B                    |
| CSP, 11-Bump | 2.05 x 1.44 x 0.644   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 14-Bump | 2.00 x 1.10 x 0.58    | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 15-Bump | 2.36 x 1.053 x 0.262  | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 15-Bump | 2.36 x 1.053 x 0.615  | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 15-Bump | 2.36 x 1.053 x 0.644  | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 15-Bump | 2.47 x 1.11 x 0.615   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 15-Bump | 2.47 x 1.14 x 0.615   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 15-Bump | 2.96 x 1.33 x 0.605   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |
| CSP, 15-Bump | 2.96 x 1.33 x 0.615   | 8 mm       | 178 mm (7")   | 3500              | 4 mm           | 4 mm           | B                    |

For orientation and dimension standards, see diagrams on page 21.

**Former CMD Tape and Reel Standards by Package**

| Package      | Package Size<br>(mm)  | Tape<br>Width | Reel Diameter | Quantity<br>per Reel | P <sub>0</sub> | P <sub>1</sub> | Orientation<br>Quadrant |
|--------------|-----------------------|---------------|---------------|----------------------|----------------|----------------|-------------------------|
| CSP, 15-Bump | 2.96 x 1.33 x 0.644   | 8 mm          | 178 mm (7")   | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 15-Bump | 3.16 x 1.053 x 0.644  | 8 mm          | 178 mm (7")   | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 15-Bump | 3.006 x 1.376 x 0.644 | 8 mm          | 178 mm (7")   | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 15-Bump | 3.01 x 1.38 x 0.644   | 8 mm          | 178 mm (7")   | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 18-Bump | 1.96 x 1.56 x 0.60    | 8 mm          | 178 mm (7")   | 5000                 | 4 mm           | 4 mm           | B                       |
| CSP, 20-Bump | 3.16 x 1.053 x 0.615  | 8 mm          | 178 mm (7")   | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 20-Bump | 3.27 x 1.11 x 0.615   | 12 mm         | 330 mm (13")  | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 20-Bump | 3.96 x 1.33 x 0.644   | 8 mm          | 178 mm (7")   | 3500                 | 4 mm           | 8 mm           | B                       |
| CSP, 20-Bump | 3.96 x 1.586 x 0.640  | 12 mm         | 330 mm (13")  | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 20-Bump | 4.00 x 1.46 x 0.605   | 12 mm         | 330 mm (13")  | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 20-Bump | 4.00 x 1.46 x 0.606   | 12 mm         | 330 mm (13")  | 3500                 | 4 mm           | 8 mm           | B                       |
| CSP, 20-Bump | 4.00 x 1.46 x 0.644   | 12 mm         | 330 mm (13")  | 3500                 | 4 mm           | 8 mm           | B                       |
| CSP, 20-Bump | 4.006 x 1.376 x 0.644 | 12 mm         | 330 mm (13")  | 3500                 | 4 mm           | 4 mm           | B                       |
| CSP, 24-Bump | 1.96 x 1.96 x 0.60    | 8 mm          | 178 mm (7")   | 5000                 | 4 mm           | 4 mm           | B                       |
| CSP, 24-Bump | 2.06 x 2.06 x 0.6     | 8 mm          | 178 mm (7")   | 5000                 | 4 mm           | 4 mm           | B                       |
| CSP, 24-Bump | 2.60 x 2.60 x 0.65    | 8 mm          | 178 mm (7")   | 500                  | 4 mm           | 4 mm           | B                       |
| CSP, 25-Bump | 2.00 x 2.00 x 0.60    | 8 mm          | 178 mm (7")   | 500                  | 4 mm           | 4 mm           | B                       |
| CSP, 49-Bump | 2.80 x 2.80 x 0.50    | 8 mm          | 178 mm (7")   | 500                  | 4 mm           | 4 mm           | B                       |
| CSP, 49-Bump | 2.80 x 2.80 x 0.60    | 8 mm          | 178 mm (7")   | 500                  | 4 mm           | 4 mm           | B                       |
| MSOP-8       | 3.00 x 3.00 x 0.85    | 12 mm         | 330 mm (13")  | 4000                 | 4 mm           | 8 mm           | A                       |
| MSOP-10      | 3.00 x 3.00 x 0.85    | 12 mm         | 330 mm (13")  | 4000                 | 4 mm           | 8 mm           | A                       |
| QSOP-16      | 4.90 x 3.89 x 1.55    | 12 mm         | 330 mm (13")  | 2500                 | 4 mm           | 8 mm           | A                       |
| QSOP-24      | 8.65 x 3.90 x 1.35    | 16 mm         | 178 mm (7")   | 1000                 | 4 mm           | 8 mm           | A                       |
| QSOP-24      | 8.65 x 3.90 x 1.35    | 16 mm         | 330 mm (13")  | 2500                 | 4 mm           | 8 mm           | A                       |
| SC70-3       | 2.05 x 1.25 x 0.95    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SC70-5       | 2.05 x 1.25 x 0.95    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SC70-5       | 2.05 x 1.25 x 0.95    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SC70-6       | 2.05 x 1.25 x 0.95    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SOD-882      | 1.00 x 0.60 x 0.50    | 8 mm          | 178 mm (7")   | 5000                 | 4 mm           | 4 mm           | A                       |
| SOIC-8       | 4.90 x 3.99 x 1.55    | 12 mm         | 330 mm (13")  | 2500                 | 4 mm           | 8 mm           | A                       |
| SOIC-8       | 4.90 x 6.00 x 1.55    | 12 mm         | 330 mm (13")  | 2500                 | 4 mm           | 8 mm           | A                       |
| SOT143       | 2.92 x 2.37 x 1.01    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SOT143-4     | 2.92 x 2.37 x 1.01    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SOT23-3      | 2.92 x 2.37 x 1.01    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SOT23-5      | 2.92 x 2.79 x 1.24    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SOT23-6      | 2.90 x 2.80 x 1.45    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | C                       |
| SOT-553      | 1.60 x 1.60 x 0.55    | 8 mm          | 178 mm (7")   | 5000                 | 4 mm           | 4 mm           | C                       |
| SOT-563      | 1.60 x 1.60 x 0.55    | 8 mm          | 178 mm (7")   | 5000                 | 4 mm           | 4 mm           | C                       |
| SOT-593      | 1.00 x 0.80 x 0.45    | 8 mm          | 178 mm (7")   | 8000                 | 4 mm           | 4 mm           | B                       |
| CUDFN-6      | 1.60 x 1.60 x 0.60    | 8 mm          | 178 mm (7")   | 2500                 | 4 mm           | 4 mm           | A                       |

For orientation and dimension standards, see diagrams on page 21.

**Former CMD Tape and Reel Standards by Package**

| Package  | Package Size<br>(mm) | Tape<br>Width | Reel Diameter | Quantity<br>per Reel | P <sub>0</sub> | P <sub>1</sub> | Orientation<br>Quadrant |
|----------|----------------------|---------------|---------------|----------------------|----------------|----------------|-------------------------|
| CUDFN-6  | 2.00 x 2.00 x 0.65   | 8 mm          | 178 mm (7")   | 2500                 | 4 mm           | 4 mm           | A                       |
| TDFN-8   | 1.70 x 1.35 x 0.75   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| TDFN-8   | 2.00 x 2.00 x 0.75   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| TDFN-8   | 3.00 x 3.00 x .075   | 12 mm         | 330 mm (13")  | 3000                 | 4 mm           | 8 mm           | A                       |
| TDFN-12  | 3.00 x 1.35 x 0.75   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| TDFN-16  | 4.00 x 1.60 x 0.75   | 12 mm         | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| TDFN-16  | 4.00 x 1.70 x 0.75   | 12 mm         | 330 mm (13")  | 3000                 | 4 mm           | 8 mm           | A                       |
| TDFN-16  | 6.00 x 4.00 x 0.75   | 12 mm         | 330 mm (13")  | 3000                 | 4 mm           | 8 mm           | A                       |
| TSSOP-8  | 3.00 x 6.38 x 1.10   | 12 mm         | 330 mm (13")  | 2500                 | 4 mm           | 8 mm           | A                       |
| TSSOP-38 | 9.70 x 6.40 x 1.20   | 16 mm         | 330 mm (13")  | 2500                 | 4 mm           | 12 mm          | A                       |
| UDFN-6   | 1.25 x 1.0 x 0.50    | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| UDFN-8   | 1.70 x 1.35 x 0.50   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| UDFN-8   | 1.70 x 1.35 x 0.50   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| UDFN-8   | 2.00 x 2.00 x 0.55   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| UDFN-12  | 2.50 x 1.20 x 0.50   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| UDFN-12  | 2.50 x 1.35 x 0.50   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| UDFN-16  | 3.30 x 1.35 x 0.50   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| uUDFN-10 | 2.50 x 1.00 x 0.50   | 8 mm          | 178 mm (7")   | 3000                 | 4 mm           | 4 mm           | A                       |
| X3DFN    | 0.62 x 0.62 x 0.32   | 8 mm          | 178 mm (7")   | 15,000               | 2 mm           | 2 mm           | Top                     |

For orientation and dimension standards, see diagrams on page 21.

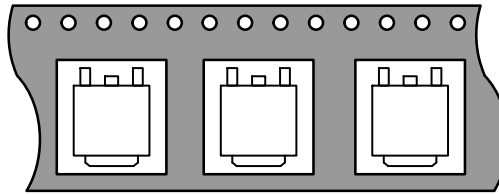
# Product Orientation

Direction of Feed



**Figure 1. D<sup>2</sup>PAK**

24 mm (Tape Width, Typical)



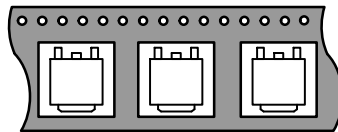
5 Lead – T4 Discrete  
R4, R5 Analog

7 Lead – R7 Analog  
PowerFLEX-7 – R7 Analog

3 Lead – T4 Discrete  
R3, R4 Analog

**Figure 2. DPAK**

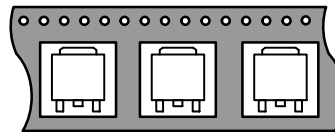
16 mm



Discrete Suffix – T4  
Analog Suffix – R or RK

**Figure 3. DPAK**

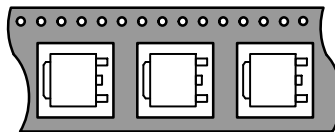
16 mm



Discrete, Analog  
Suffix – T5

**Figure 4. DPAK**

16 mm



Discrete Suffix – RL

## Product Orientation (continued)

Direction of Feed



Figure 5. SOT-883

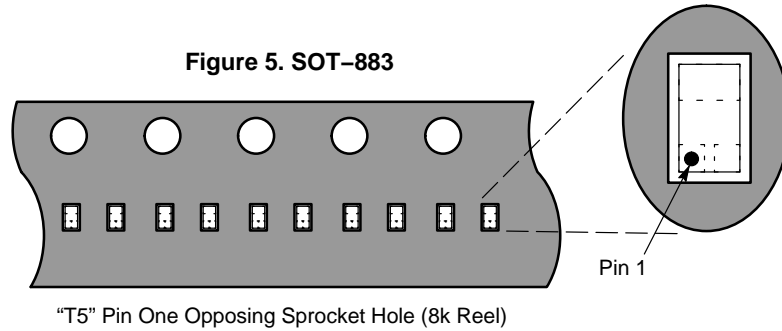


Figure 6. DSN

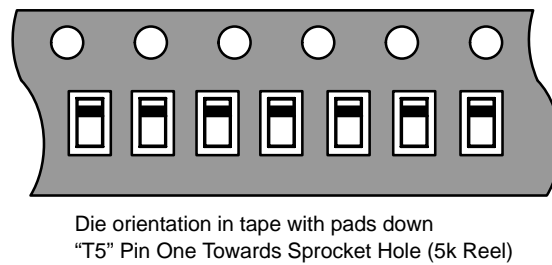


Figure 7. WLCSP, Flip-Chip/DCA

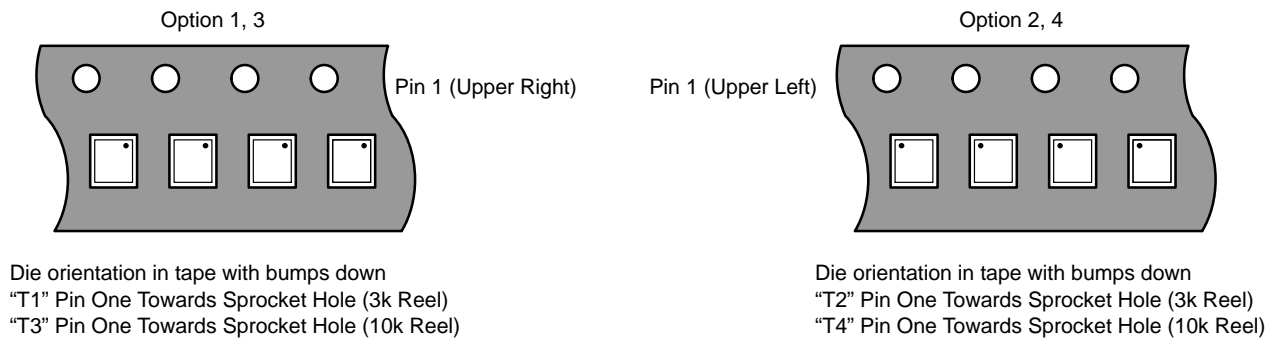


Figure 8. LQFP, TQFP

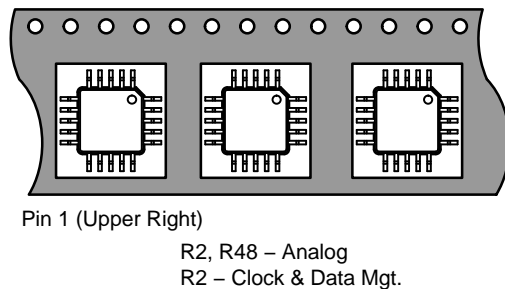
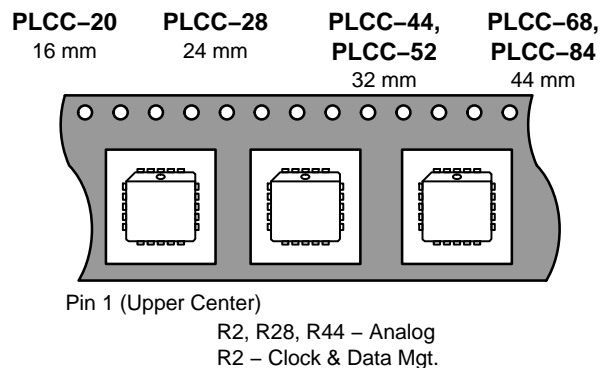


Figure 9. PLCC



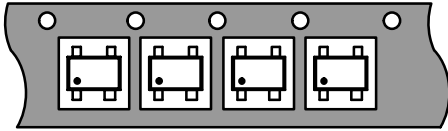
## Product Orientation (continued)

Direction of Feed



**Figure 10. SC82 / SC82-AB**

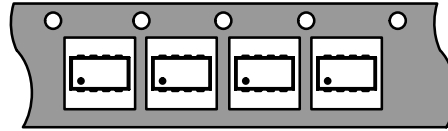
"TR" Suffix – Option 1, 3



"T1" Pin One Opposing Sprocket Hole (3k Reel)  
"T3" Pin One Opposing Sprocket Hole (10k Reel)

**Figure 11. ChipFET (8-Lead)**

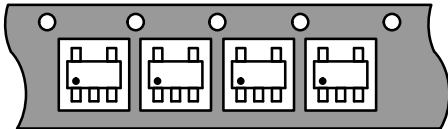
"T1" Suffix – Option 1



"T1" Pin One Opposing Sprocket Hole (3k Reel)

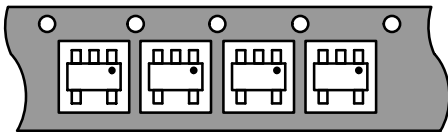
**Figure 12. TSOP-5 / SOT23-5 / SC-74A**

"T" or "TR" Suffix – Option 1, 3



"T1" Pin One Opposing Sprocket Hole (3k Reel)  
"T3" Pin One Opposing Sprocket Hole (10k Reel)

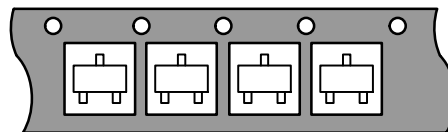
Option 2



"T2" Pin One Toward Sprocket Hole (3k Reel)

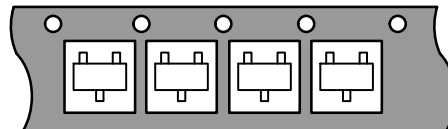
**Figure 13. SOT-23 / SOT-23L / SOT-323 / SC-59 / SC-70 / SC-75 / SC-89**

"T5", "TR" or "R2" Suffix – Option 1, 3



"T1" Single Lead Toward Sprocket Hole (3k Reel)  
"T5" Single Lead Toward Sprocket Hole (8k Reel)  
"T3" Single Lead Toward Sprocket Hole (10k Reel)

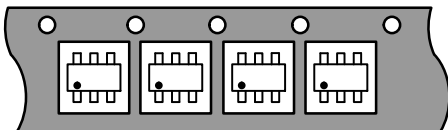
Option 2



"T2" Single Lead Opposing Sprocket Hole (3k Reel)  
(This Orientation Applies to SC-59 Only)

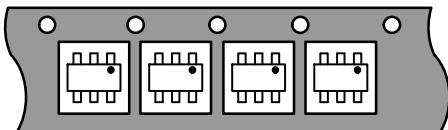
**Figure 14. TSOP-6 / SOT23-6 / SC-74**

"T" or "TR" Suffix – Option 1, 3



"T1" Pin One Opposing Sprocket Hole (3k Reel)  
"T3" Pin One Opposing Sprocket Hole (10k Reel)

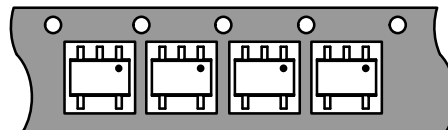
Option 2



"T2" Pin One Toward Sprocket Hole (3k Reel)

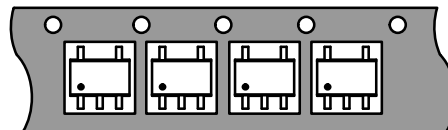
**Figure 15. SC-88A / SC70-5 / SOT-353**

Option 1, 3



"T1" Pin One Toward Sprocket Hole (3k Reel)  
"T3" Pin One Toward Sprocket Hole (10k Reel)

Option 2, 4



"T2" Pin One Opposing Sprocket Hole (3k Reel)  
"T4" Pin One Opposing Sprocket Hole (10k Reel)



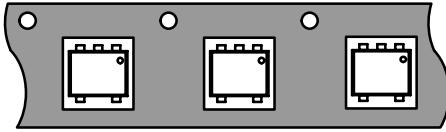
## Product Orientation (continued)

Direction of Feed



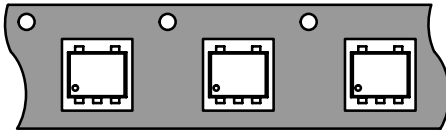
**Figure 16. SOT-553**

Option 1



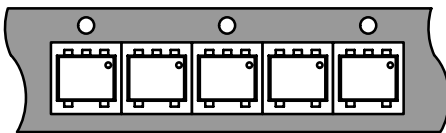
"T1" Pin One Toward Sprocket Hole (4k Reel)

Option 2



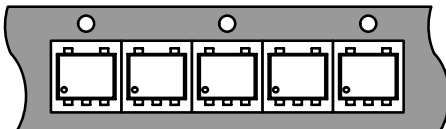
"T2" Pin One Opposing Sprocket Hole (4k Reel)

Option 5



"T5" Pin One Toward Sprocket Hole (8k Reel)

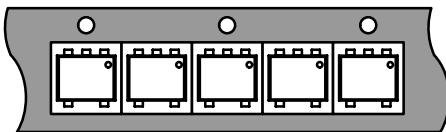
Option 6



"T6" Pin One Opposing Sprocket Hole (8k Reel)

**Figure 18. SOT-953**

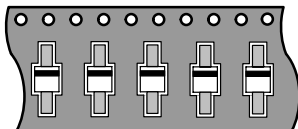
Option 5



"T5" Pin One Toward Sprocket Hole (8k Reel)

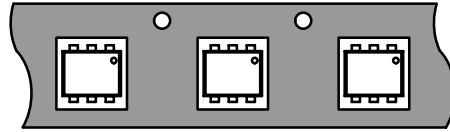
**Figure 20. POWERMITE®**

"T1" Suffix – Option 1



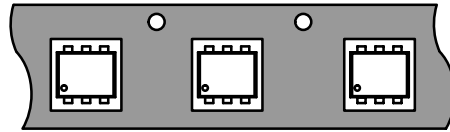
**Figure 17. SOT-563**

Option 1



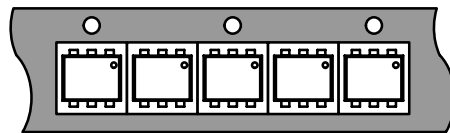
"T1" Pin One Toward Sprocket Hole (4k Reel)

Option 2



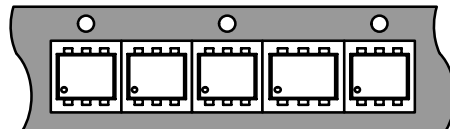
"T2" Pin One Opposing Sprocket Hole (4k Reel)

Option 5



"T5" Pin One Toward Sprocket Hole (8k Reel)

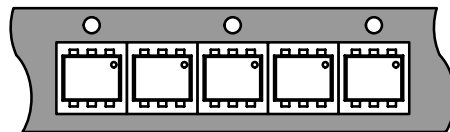
Option 6



"T6" Pin One Opposing Sprocket Hole (8k Reel)

**Figure 19. SOT-963**

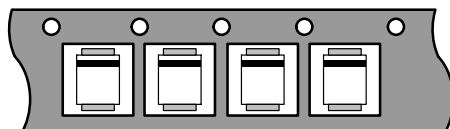
Option 5



"T5" Pin One Toward Sprocket Hole (8k Reel)

**Figure 21. SMA, SMB, SMC**

"TR" or "R2" Suffix – Option 1, 3



**Unidirectional**

**SMA:** "T1" Cathode Toward Sprocket Hole (1.5k Reel)

"T3" Cathode Toward Sprocket Hole (5k Reel)

**SMB/SMC:** "T1" Cathode Toward Sprocket Hole (1k Reel)

"T3" Cathode Toward Sprocket Hole (2.5k Reel)

**Bidirectional**

Same as above except no orientation

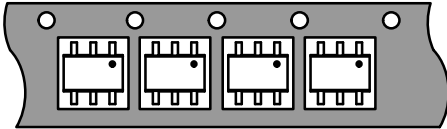
## Product Orientation (continued)

Direction of Feed



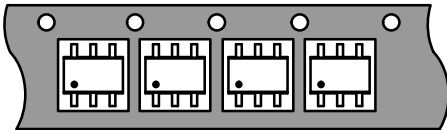
**Figure 22. SC-88 / SC70-6 / SOT-363**

Option 1, 3



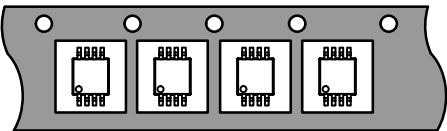
"T1" Pin One Toward Sprocket Hole (3k Reel)  
"T3" Pin One Toward Sprocket Hole (10k Reel)

Option 2



"T2" Pin One Opposing Sprocket Hole (3k Reel)

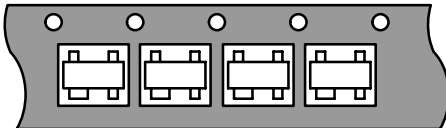
**Figure 24. ULTRA SMALL 8**



Pin One Opposing Sprocket Hole (3k Reel)

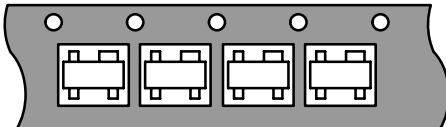
**Figure 25. SOT-143**

"T" or "TR" Suffix – Option 1, 3



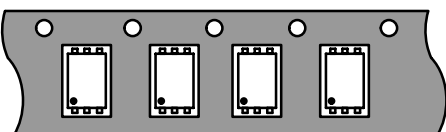
"T1" Wide Lead Tape Opposing Sprocket Hole (3k Reel)  
"T3" Wide Lead Tape Opposing Sprocket Hole (10k Reel)

Option 2, 4



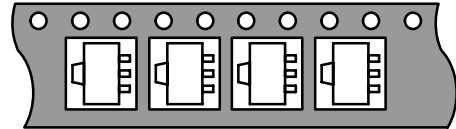
"T2" Wide Lead Tape Toward Sprocket Hole (3k Reel)  
"T4" Wide Lead Tape Toward Sprocket Hole (10k Reel)

**Figure 27. SON-6**



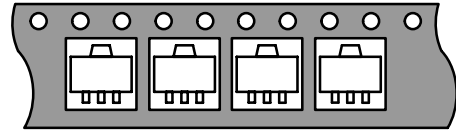
**Figure 23. SOT-89**

"R1" Suffix



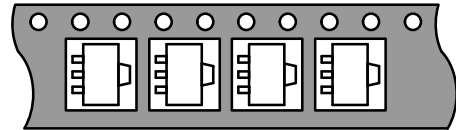
"R1" Pin One Opposing Sprocket Hole (1k Reel)

"T1" Suffix



"T1" Single Lead Toward Sprocket Hole (1k Reel)

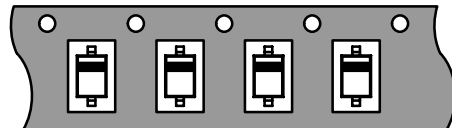
"T2" Suffix



"T2" Single Lead Opposing Sprocket Hole (1k Reel)

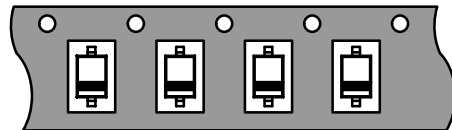
**Figure 26. SOD-123 / SOD-323**

Option 1, 3



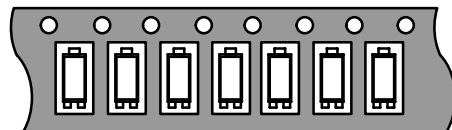
"T1" Cathode Lead Toward Sprocket Hole (3k Reel)  
"T3" Cathode Lead Toward Sprocket Hole (10k Reel)

Option 2



"T2" Cathode Lead Opposing Sprocket Hole (3k Reel)

**Figure 28. SOT-1123**



"T5" Single Lead Toward Sprocket Hole (8k Reel)

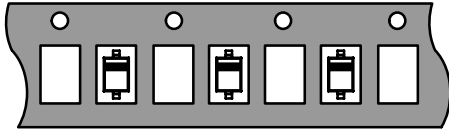
## Product Orientation (continued)

Direction of Feed



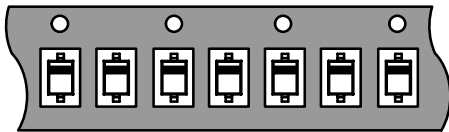
**Figure 29. SOD-523**

Option 1



"T1" Cathode Lead Toward Sprocket Hole (3k Reel)

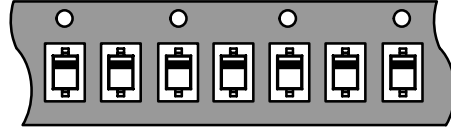
Option 5



"T5" Cathode Lead Toward Sprocket Hole (8k Reel)

**Figure 30. SOD-723, SOD-923**

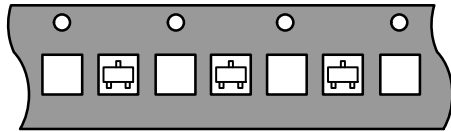
Option 5



"T5" Cathode Lead Toward Sprocket Hole (8k Reel)

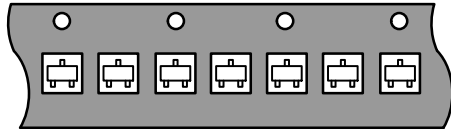
**Figure 32. SOT-723**

Option 1



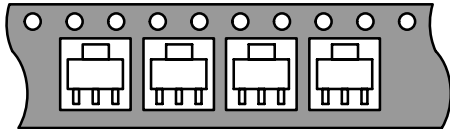
"T1" Single Lead Toward Sprocket Hole (4k Reel), 4mm pitch  
(unit between two sprocket holes)

Option 2



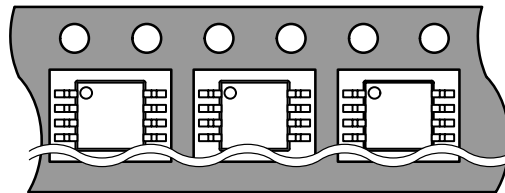
"T5" Single Lead Toward Sprocket Hole (8k Reel), 2mm pitch

**Figure 31. SOT-223**



"T1" Single Lead Toward Sprocket Hole (1k Reel)  
"T3" Single Lead Toward Sprocket Hole (4k Reel)  
"R3" Single Lead Toward Sprocket Hole (2.5k Reel)

**Figure 33. Micro8™ / Micro10 / SO / SOIC / SOIC-EIAJ / SOP / SSOP / TSSOP**

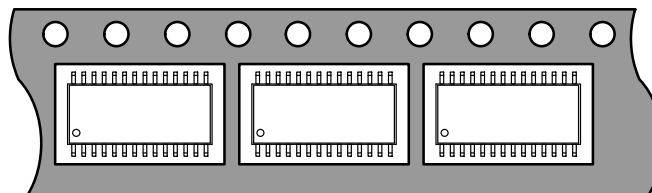


Pin 1 (Upper Left)

EL – Logic  
R2 – Clock & Data Mgt.  
R or R2 – Analog  
T2 or T3 – EEPROM

**Figure 34. SO-28W**

32 mm



R3 – Analog

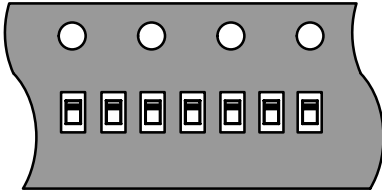
## Product Orientation (continued)

Direction of Feed



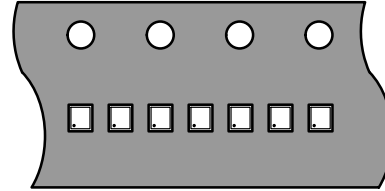
### Leadless Packages

Figure 35. X3DFN



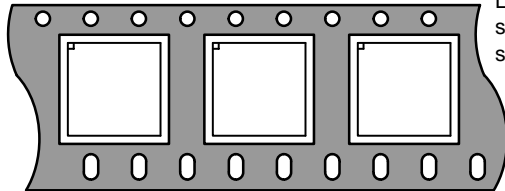
T5 – Cathode Band Toward Sprocket Hole (15k Reel)

Figure 36. XLLGA, DFN



T2 – Pin One Opposing Sprocket Hole (3k Reel)  
T5 – Pin One Opposing Sprocket Hole (8k Reel)

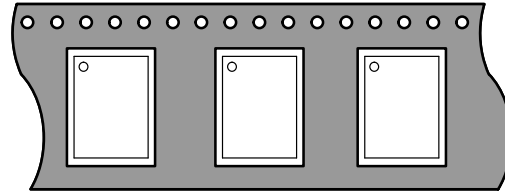
Figure 37. FCBGA (BGA)



TA, TW

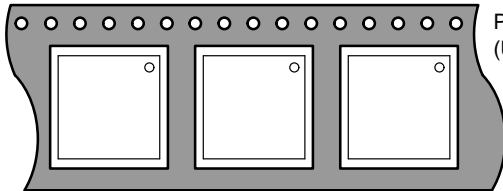
Pin 1 (Upper Left)  
(On circular sprocket hole side of the tape)

Figure 38. DFN/QFN/WLCSP-5



TA, TW, TR

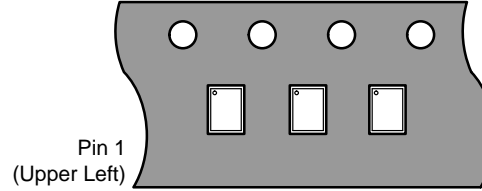
Figure 39. DFN/QFN (LPCC)/  
WLCSP-4/XDFN2



TB, TX, TR, T5

Pin 1  
(Upper Right)

Figure 40. WLCSP 8-Bump,  
10-Bump, 12-Bump



Pin 1  
(Upper Left)

| Package                      | Pre Jan 2007 | Post Jan 2007 |
|------------------------------|--------------|---------------|
| DFN / QFN Square (LPCC)      | T1           | TB, TX        |
|                              | T4           | TB, TX        |
|                              | R2           | TB, TX        |
| DFN / QFN Rectangular (LPCC) | T1           | TA, TW        |
|                              | R2           | TA, TW        |
| DFN / QFN                    | T2           | TA, TW        |
|                              | R2           | TA, TW        |
| FCBGA / BGA                  | R2           | TA, TW        |
| WLCSP                        | –            | TR            |

# Leadless Package Pin 1 Orientation for Tape and Reel (QFN, DFN, FCBGA, BGA, LPCC)

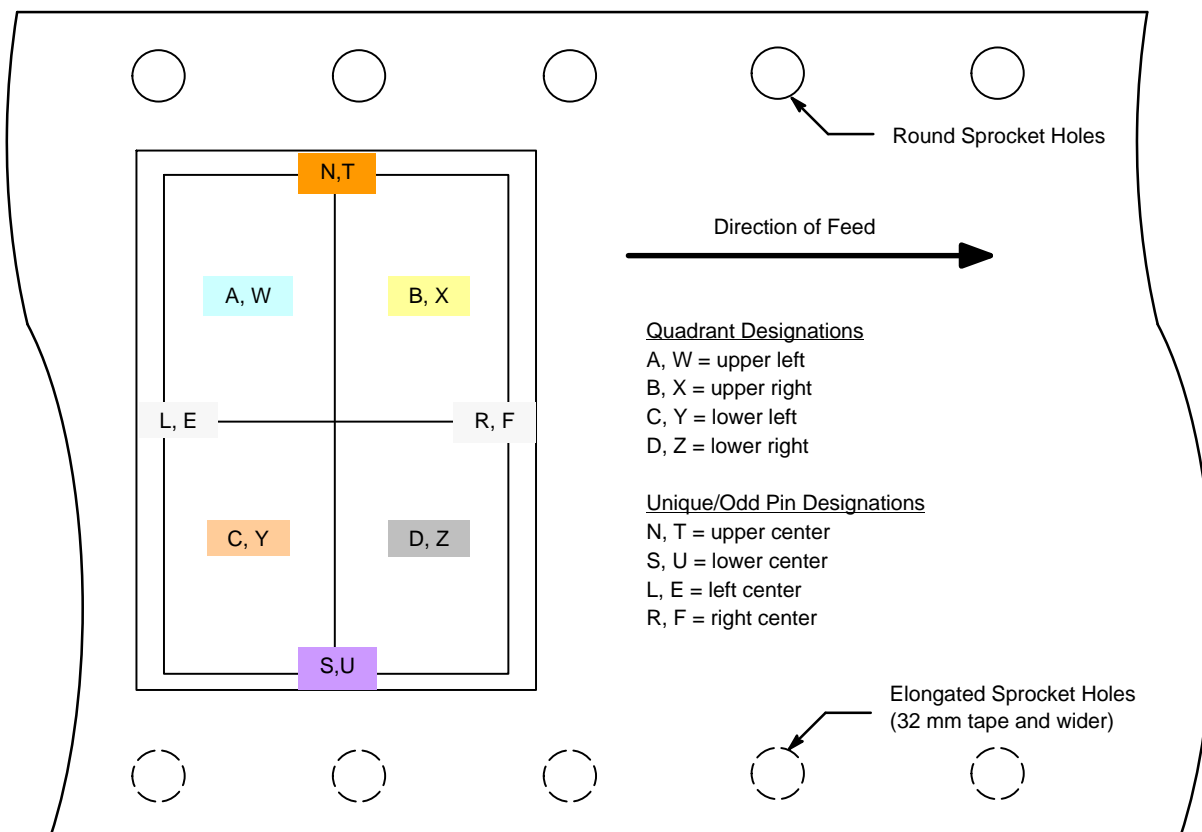
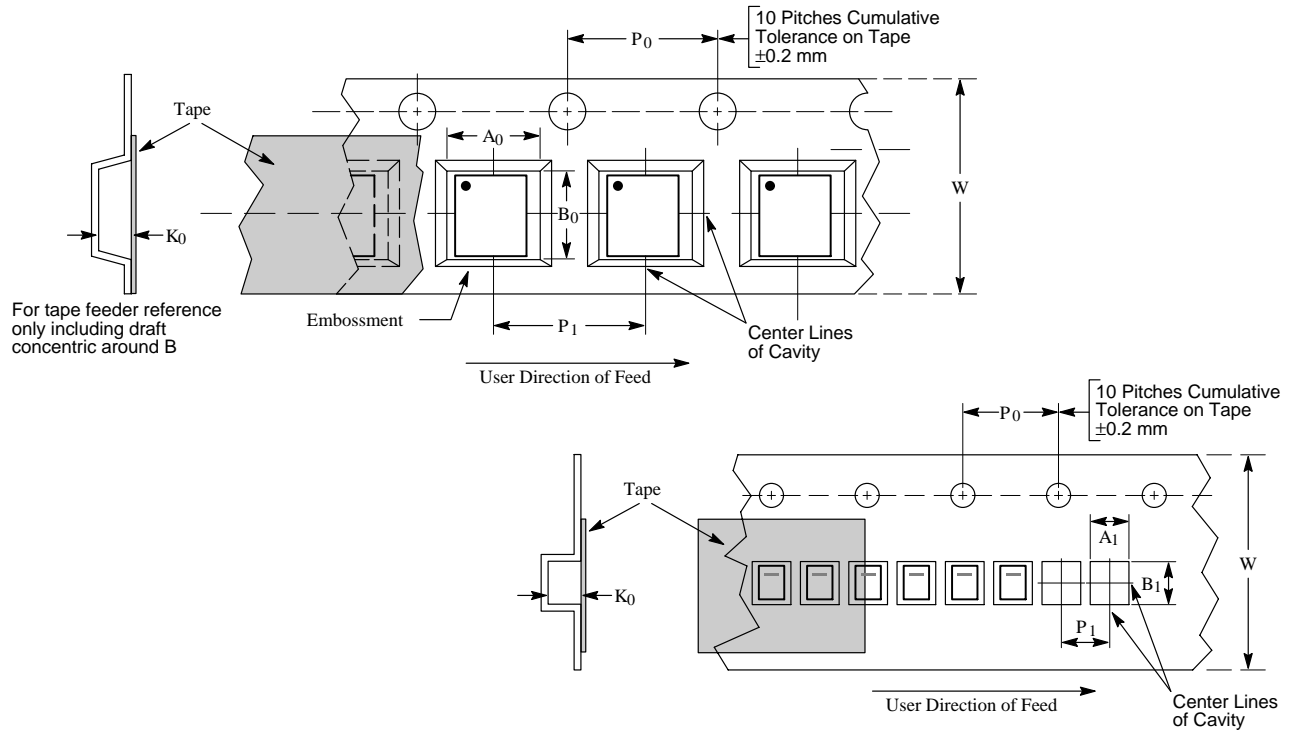


Figure 41. Leadless Package Pin 1 Orientation for Tape and Reel (Effective January 2007)

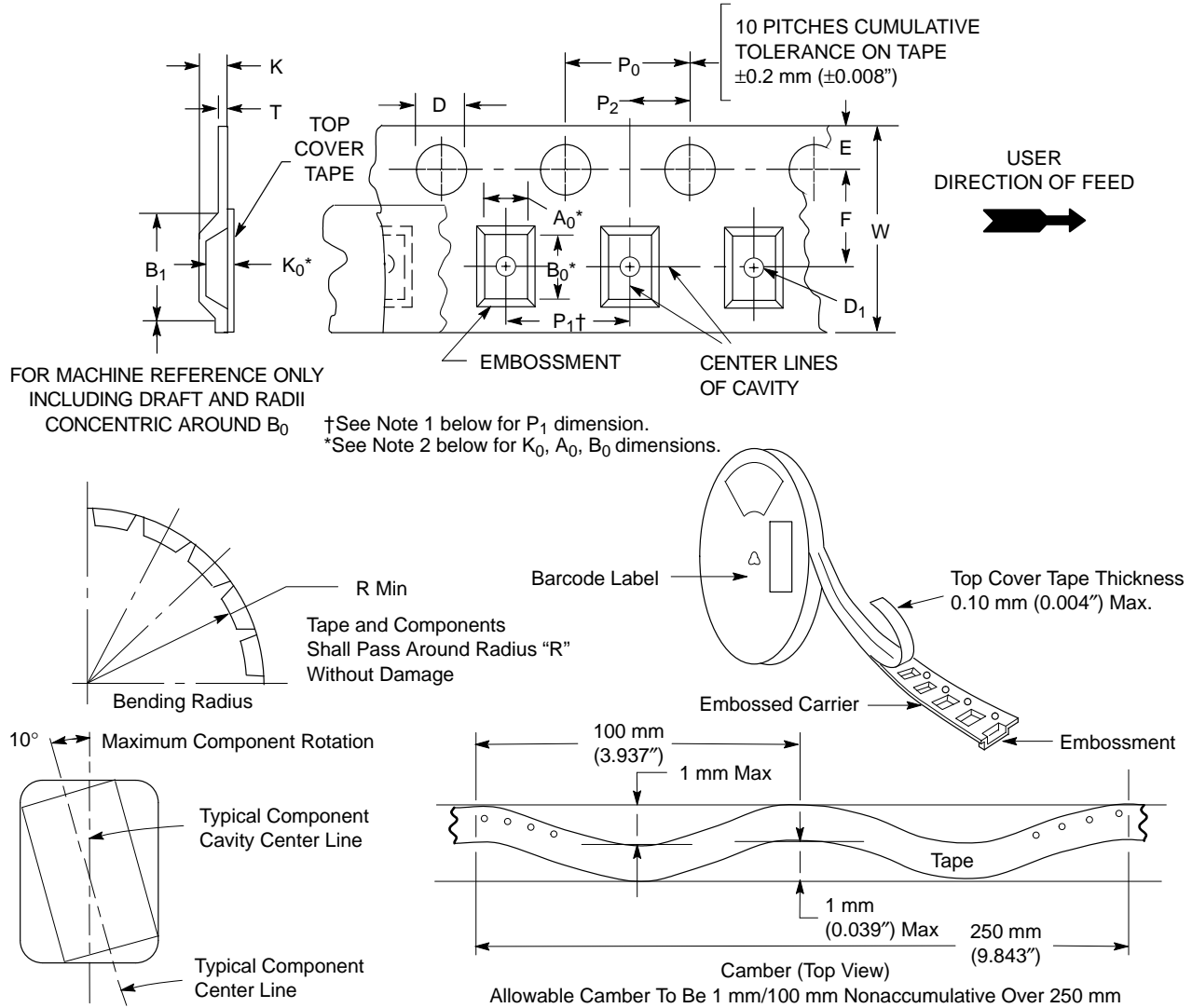
| Part Number Suffix |               |                  |                         |                         |
|--------------------|---------------|------------------|-------------------------|-------------------------|
| Shipping Type*     | Pin1 Location | Blank or Pb-Free | Remark:                 | Reel Size (mm) diameter |
| T                  | A             | G                | Quadrant 1--upper left  | 177                     |
| T                  | B             | G                | Quadrant 2--upper right | 178                     |
| T                  | C             | G                | Quadrant 3--lower left  | 178                     |
| T                  | D             | G                | Quadrant 4--lower right | 178                     |
| T                  | W             | G                | Quadrant 1--upper left  | 330                     |
| T                  | X             | G                | Quadrant 2--upper right | 330                     |
| T                  | Y             | G                | Quadrant 3--lower left  | 330                     |
| T                  | Z             | G                | Quadrant 4--lower right | 330                     |
| T                  | N             | G                | North (upper center)    | 178                     |
| T                  | S             | G                | South (lower center)    | 178                     |
| T                  | T             | G                | Top (upper center)      | 330                     |
| T                  | U             | G                | Under (lower center)    | 330                     |
| T                  | L             | G                | Left center             | 178                     |
| T                  | R             | G                | Right center            | 178                     |
| T                  | E             | G                | Left center             | 330                     |
| T                  | F             | G                | Right center            | 330                     |

\*T = Tape

# Tape and Reel Dimensions and Orientation for Former CMD Devices



# Embossed Tape and Reel Data Carrier Tape Standards



## DIMENSIONS

| Tape Size (W) | $B_1$ Max (Note 1) | D  | $D_1$  | E                                  | F                                  | K                    | $P_0$                             | $P_2$                             | R Min         | T Max           | W Max                             |
|---------------|--------------------|--|--|------------------------------------|------------------------------------|----------------------|-----------------------------------|-----------------------------------|---------------|-----------------|-----------------------------------|
| 8 mm          | 4.55 mm (0.179")   | $1.5 \pm 0.1$ mm<br>(0.059 + 0.004" - 0.0) | 1.0 Min (0.039") or 0.5 mm Min (0.020") or 0.2 mm Min (0.008") | $1.75 \pm 0.1$ mm (0.069 ± 0.004") | $3.5 \pm 0.05$ mm (0.138 ± 0.002") | 2.4 mm Max (0.094")  | $4.0 \pm 0.1$ mm (0.157 ± 0.004") | $2.0 \pm 0.1$ mm (0.079 ± 0.002") | 25 mm (0.98") | 0.6 mm (0.024") | 8.3 mm (0.327")                   |
| 12 mm         | 8.2 mm (0.323")    |  | 1.5 mm Min (0.060")  |                                    | $5.5 \pm 0.05$ mm (0.217 ± 0.002") | 6.4 mm Max (0.252")  |                                   |                                   | 30 mm (1.18") |                 | $12 \pm 0.30$ mm (0.470 ± 0.012") |
| 16 mm         | 12.1 mm (0.476")   |  |  |                                    | $7.5 \pm 0.10$ mm (0.295 ± 0.004") | 7.9 mm Max (0.311")  |                                   |                                   |               |                 | 16.3 mm (0.642")                  |
| 24 mm         | 20.1 mm (0.791")   |  |  |                                    | $11.5 \pm 0.1$ mm (0.453 ± 0.004") | 11.9 mm Max (0.468") |                                   |                                   |               |                 | 24.3 mm (0.957")                  |

Metric dimensions govern – English are in parentheses for reference only.

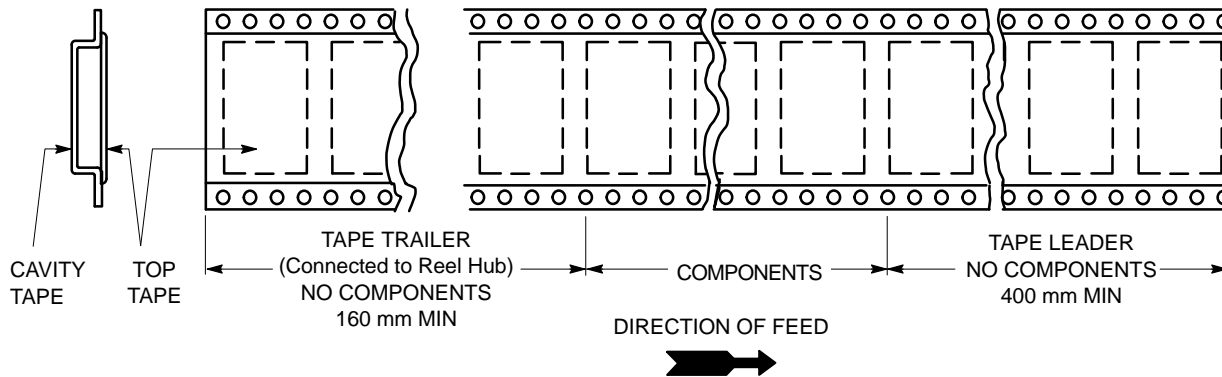
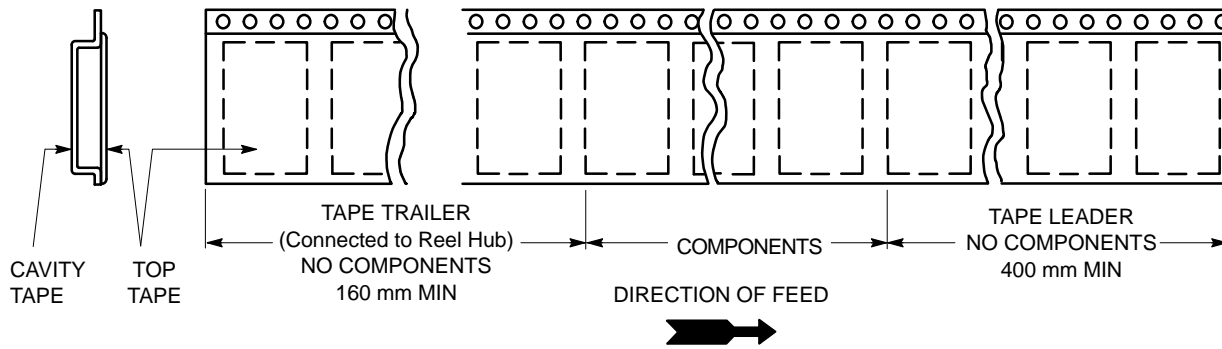
- Pitch information (dimension  $P_1$ ) is contained in the embossed tape and reel ordering information beginning on Page 5.
- $A_0$ ,  $B_0$ , and  $K_0$  are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min to 0.50 mm max. The component cannot rotate more than 10° within the determined cavity.

# Tape Ends for Finished Goods

## Leader and Trailer

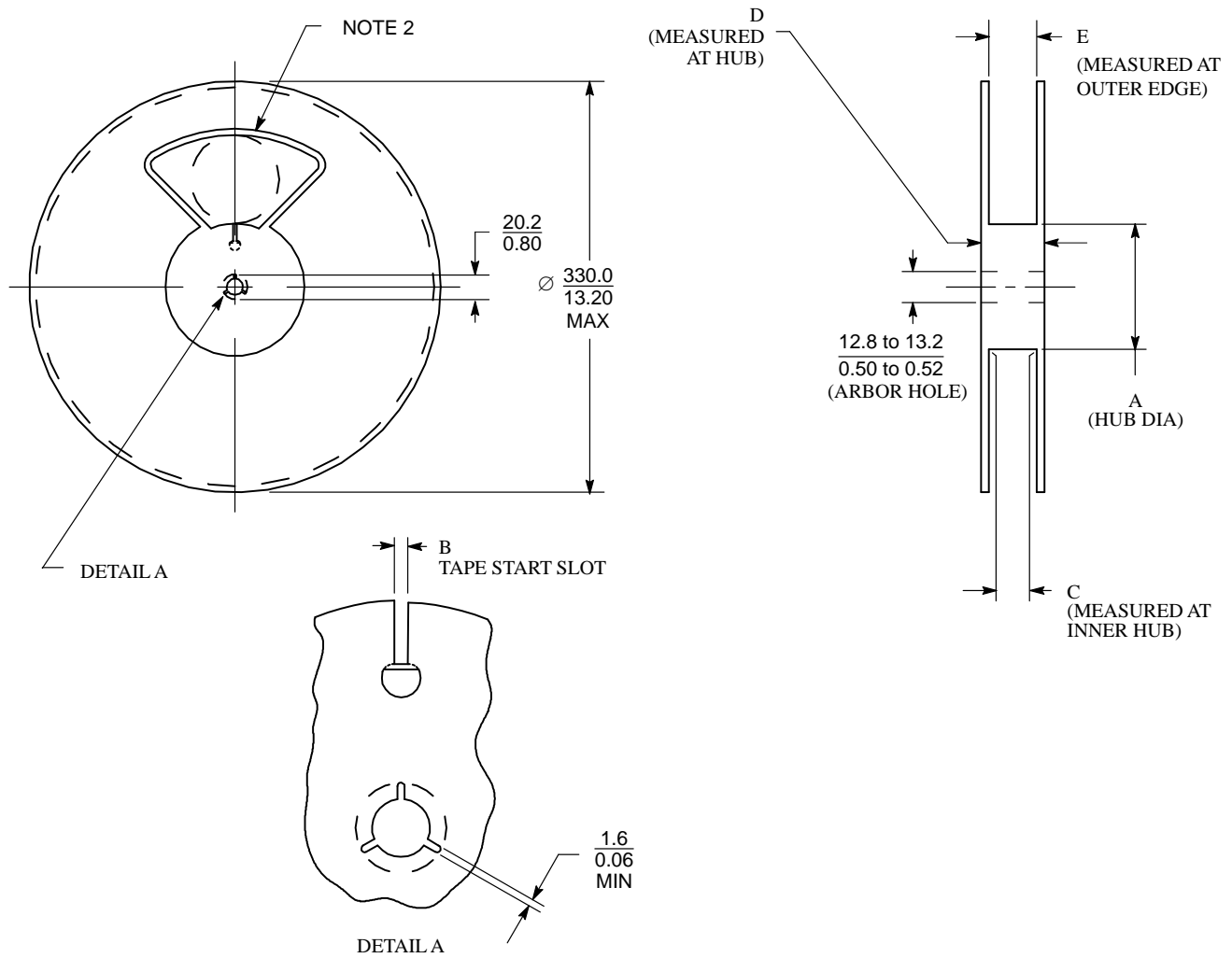
The TRAILER is a minimum of 160 mm in length and it consists of empty cavities with sealed cover tape.

The LEADER is a minimum of 400 mm in length and it consists of empty cavities with sealed cover tape.





# Reel Dimensions



| Reel Diameter | Tape Size   | A<br>mm (inches) |             | B<br>mm (inches) |             | C<br>mm (inches) |             | D<br>(Max)  | E<br>(Max)  |
|---------------|-------------|------------------|-------------|------------------|-------------|------------------|-------------|-------------|-------------|
|               |             | Min              | Max         | Min              | Max         | Min              | Max         |             |             |
| 178.0 (7.01)  | 16.0 (0.63) |                  | 50.0 (1.97) | 6.5 (0.26)       | 7.5 (0.30)  | 16.4 (0.65)      | 18.4 (0.72) | 22.4 (0.88) | 19.4 (0.76) |
| 330.0 (12.99) | 12.0 (0.47) | 178.0 (7.01)     |             | 4.5 (0.18)       | 5.5 (0.22)  | 12.4 (0.49)      | 14.4 (0.57) | 18.4 (0.72) | 15.4 (0.61) |
| 330.0 (12.99) | 56.0 (2.20) | 150.0 (5.91)     |             | 10.0 (0.39)      | 11.0 (0.43) | 56.4 (2.22)      | 58.4 (2.30) | 62.4 (2.46) | 59.4 (2.34) |
| 330.0 (12.99) | 44.0 (1.73) | 100.0 (3.94)     |             | 10.0 (0.39)      | 11.0 (0.43) | 44.4 (1.75)      | 46.4 (1.83) | 62.4 (2.46) | 47.4 (1.87) |
| 330.0 (12.99) | 32.0 (1.26) | 100.0 (3.94)     |             | 10.0 (0.39)      | 11.0 (0.43) | 32.4 (1.28)      | 34.4 (1.35) | 38.4 (1.51) | 35.4 (1.39) |
| 330.0 (12.99) | 24.0 (0.94) | 60.0 (2.36)      |             | 9.5 (0.37)       | 10.5 (0.41) | 24.4 (0.96)      | 26.4 (1.04) | 30.4 (1.51) | 27.4 (1.08) |
| 330.0 (12.99) | 16.0 (0.63) |                  |             | 6.5 (0.26)       | 7.5 (0.30)  | 16.4 (0.65)      | 18.4 (0.72) | 22.4 (0.88) | 19.4 (0.76) |
| 330.0 (12.99) | 12.0 (0.47) |                  |             | 4.5 (0.18)       | 5.5 (0.22)  | 12.4 (0.49)      | 14.4 (0.57) | 18.4 (0.72) | 15.4 (0.61) |
| 330.0 (12.99) | 8.0 (0.31)  | 50.0 (1.97)      |             | 2.5 (0.10)       | 3.5 (0.14)  | 8.4 (0.33)       | 9.9 (0.39)  | 14.4 (0.57) | 10.9 (0.43) |
| 178.0 (7.01)  | 12.0 (0.47) | 50.0 (1.97)      |             | 4.5 (0.18)       | 5.5 (0.22)  | 12.4 (0.49)      | 14.4 (0.57) | 18.4 (0.72) | 15.4 (0.61) |
| 178.0 (7.00)  | 8.0 (0.31)  | 50.0 (1.97)      |             | 2.5 (0.10)       | 3.5 (0.14)  | 8.4 (0.33)       | 9.9 (0.39)  | 14.4 (0.47) | 10.9 (0.43) |
| 330.0 (12.99) | 8.0 (0.31)  | 50.0 (1.97)      |             | 4.0 (0.16)       | 5.0 (0.20)  | 8.4 (0.33)       | 9.9 (0.39)  | 14.4 (0.57) | 10.9 (0.43) |
| 178.0 (7.00)  | 8.0 (0.31)  | 50.0 (1.97)      |             | 4.0 (0.16)       | 5.0 (0.20)  | 8.4 (0.33)       | 9.9 (0.39)  | 14.4 (0.57) | 10.9 (0.43) |

## Reel Dimensions (continued)

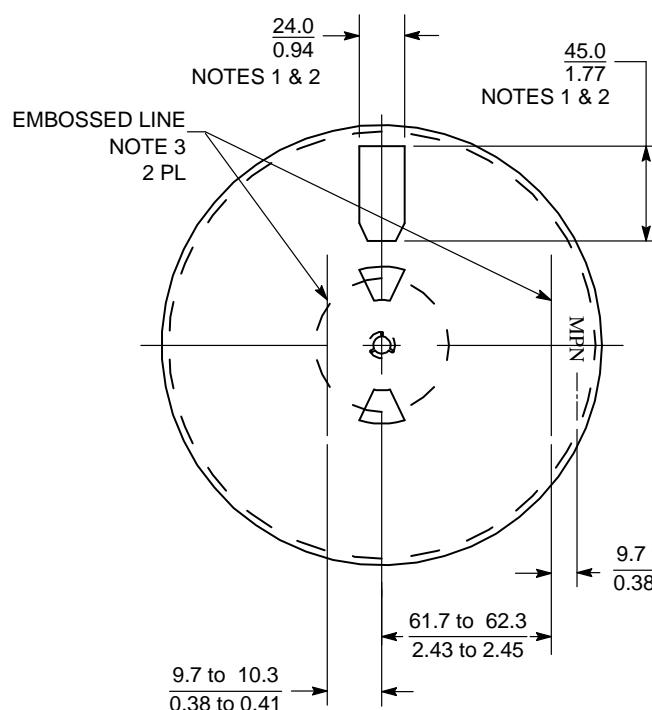


Figure 42. Front View of 178 mm (7.0 in) Reel

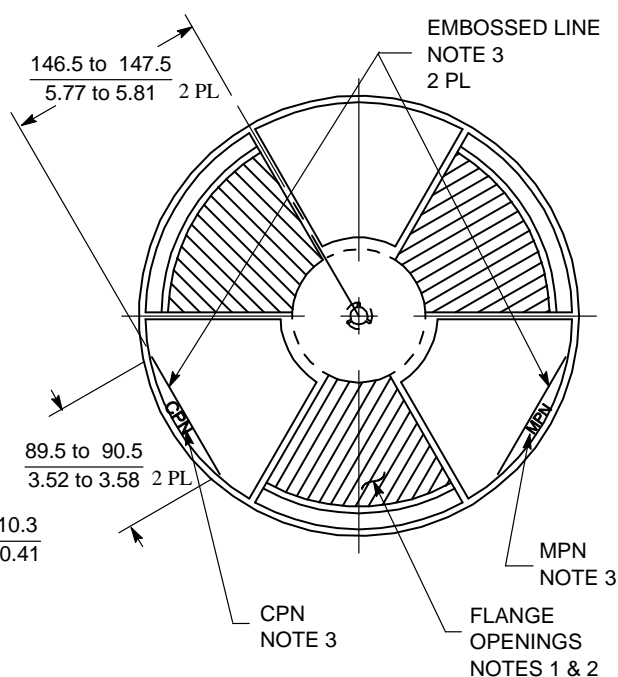


Figure 43. Front View of 330 mm (12.99 in) Reel

### NOTES:

#### 1. LABEL PLACEMENT AREA:

- All reels must have flat area on the front flange of the reel that will fit two 41.3 mm (1.65 in) by 125 mm (4.90 in) ON Semiconductor barcode labels.
- If there are any flange openings on the front side of the 178 mm (7.00 in) reel they must be designed in locations so that two of the 41.3 mm (1.65 in) ON Semiconductor barcode labels can be applied parallel to each other as in Figure 42.
- If there are any flange opening on the front flange of the 330 mm (13.0 in) reel they must be designed in locations so that two of the 41.3 mm (1.65 in) by 125 mm (4.90 in) ON Semiconductor barcode labels can be applied parallel to each other as in Figure 43.

#### 2. FLANGE OPENINGS

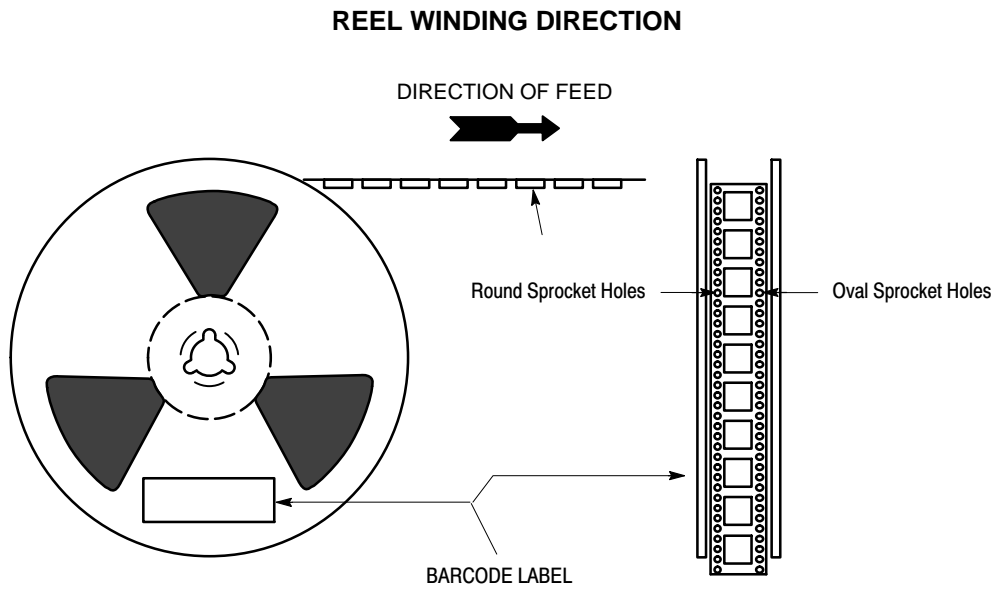
- Flange opening on the front and the back of the reel are a supplier option but must meet all of the requirements in Note 1. The preferred size for the 176 mm (7.0 in) reel is shown in Figure 42.
- The tape loading opening must be as in Detail A.

#### 3. GRAPHICS:

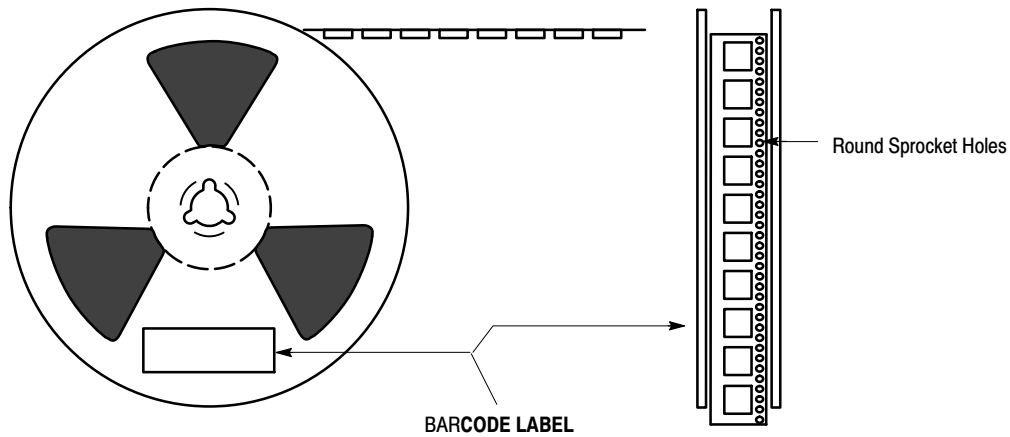
- The letters MPN and CPN are a option. The size and thickness of the letters are the manufacturer's option and are not to be used for inspection criteria.
- The embossed lines on the reel are a option. If the lines are used they must be located as in Figure 42 and 43. They must be a minimum 38 mm (1.50 in) long. The thickness is a manufacturer's option and not to be used for inspection criteria.

# Reel Labeling

Place the reel on an ESD protective surface so that the round sprocket holes are on the bottom. The direction of travel when unwound should be from the top right quadrant. See illustration below.

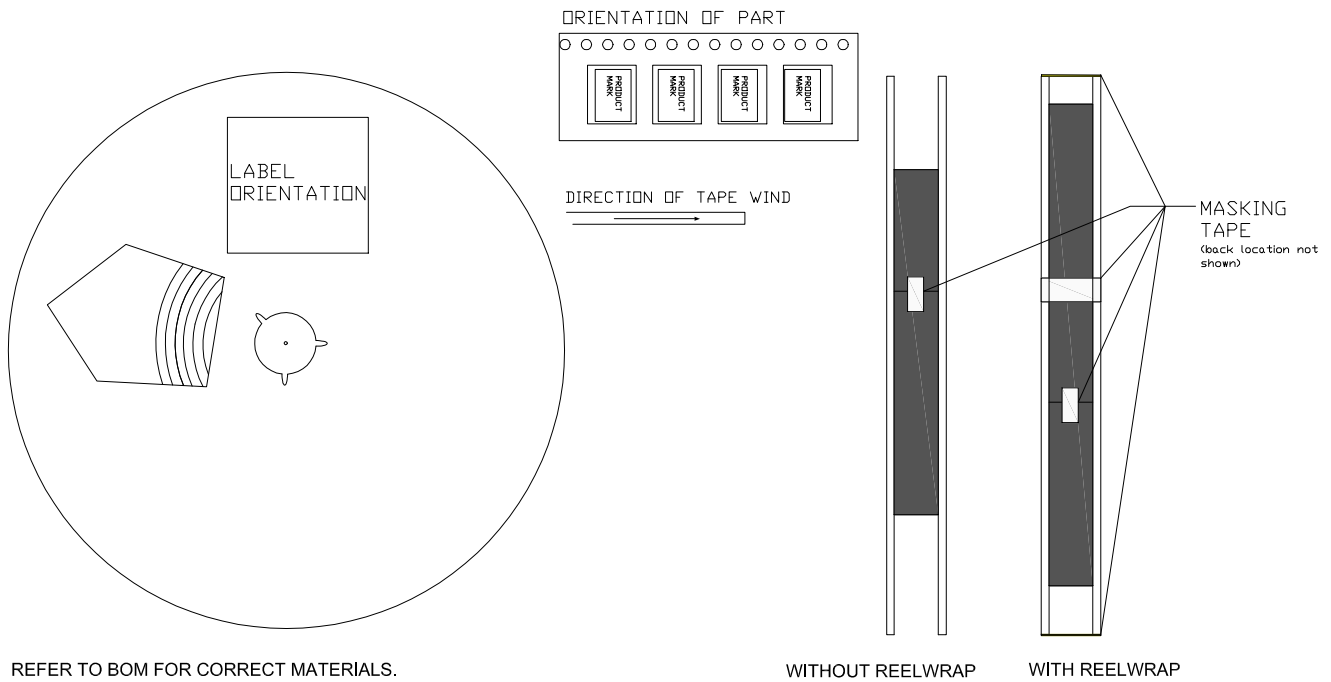


**Figure 44. Round and Oval Sprocket Holes Used with 32 mm, 42 mm, 44 mm and 52 mm Tape (holes on both sides)**



**Figure 45. Round Sprocket Holes Used with 8 mm, 12 mm, 16 mm and 24 mm Tape (holes on one side only)**

## REEL ORIENTATION FOR LGA17, SIP21 AND SIP33 PACKAGES



REFER TO BOM FOR CORRECT MATERIALS.

MASKING TAPE APPLIED IN 6 LOCATIONS:  
 1) SECURE CARRIER TAPE  
 2) SECURE REELWRAP  
 3-6) 4 LOCATIONS AROUND REEL TO FURTHER SECURE REELWRAP

**Figure 46. REEL ORIENTATION FOR LGA17, SIP21 AND SIP33 PACKAGES**

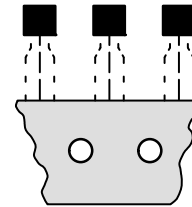
# TO-92 EIA, IEC, EIAJ

## Radial Tape in Fan Fold Box or On Reel

Radial tape in fan fold box or on reel of the reliable TO-92 package are the best methods of capturing devices for automatic insertion in printed circuit boards. These methods of taping are compatible with various equipment for active and passive component insertion.

- Available in Fan Fold Box
- Available on 365 mm Reels
- Accommodates All Standard Inserters
- Allows Flexible Circuit Board Layout
- 2.5 mm Pin Spacing for Soldering
- EIA-468, IEC 286-2, EIAJ RC1008B

### TO-92 RADIAL TAPE IN FAN FOLD BOX OR ON REEL



#### Ordering Notes:

When ordering radial tape in fan fold box or on reel, specify the style per Figures 48, 49, 55 and 56. Add the suffix “RLR” and “Style” to the device title, i.e. 2N5060RLRA. This will be a standard 2N5060 radial taped and supplied on a reel. Some products only utilize the last 2 digits. Please refer to the ON Semiconductor device data sheet for exact ordering information.

- Fan Fold Box Information – Minimum order quantity 1 Box. Order in increments of 2000.
- Reel Information – Minimum order quantity 1 Reel. Order in increments of 2000.

#### US/EUROPEAN SUFFIX CONVERSIONS

| U.S.     | Europe | Package Style |
|----------|--------|---------------|
| RLRA, RA | RL     | Reel          |
| RLRE, RE | RL1    | Reel          |
| RLRM, RM | ZL1    | Fan Fold      |
| RLRP, RP | –      | Fan Fold      |

# TO-92 EIA RADIAL TAPE IN FAN FOLD BOX OR ON REEL

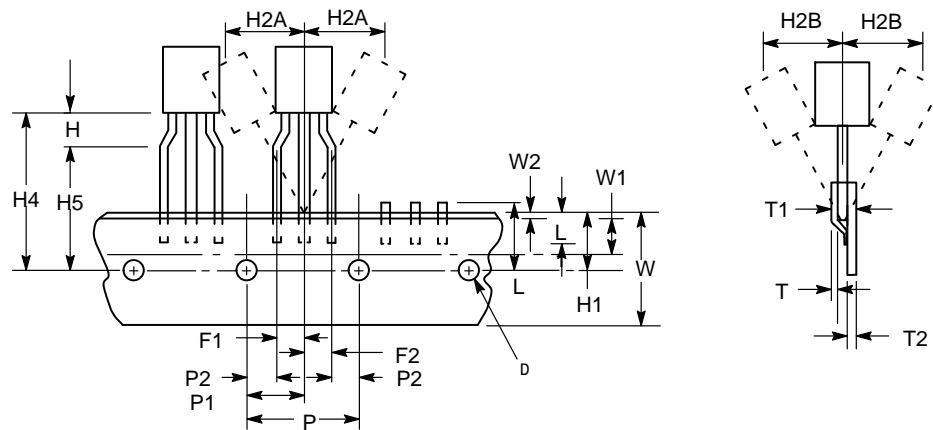


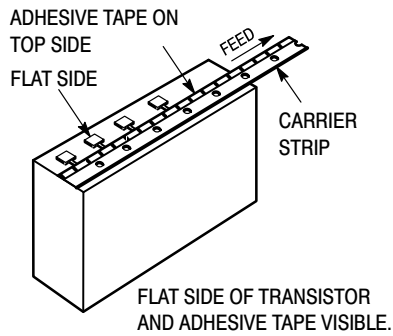
Figure 47. Device Positioning on Tape

| Symbol | Item                                 | Specification |         |            |      |
|--------|--------------------------------------|---------------|---------|------------|------|
|        |                                      | Inches        |         | Millimeter |      |
|        |                                      | Min           | Max     | Min        | Max  |
| D      | Tape Feedhole Diameter               | 0.1496        | 0.1653  | 3.8        | 4.2  |
| D2     | Component Lead Thickness Dimension   | 0.015         | 0.020   | 0.38       | 0.51 |
| F1, F2 | Component Lead Pitch                 | 0.0945        | 0.110   | 2.4        | 2.8  |
| H      | Bottom of Component to Seating Plane | 0.059         | 0.156   | 1.5        | 4.0  |
| H1     | Feedhole Location                    | 0.3346        | 0.3741  | 8.5        | 9.5  |
| H2A    | Deflection Left or Right             | 0             | 0.039   | 0          | 1.0  |
| H2B    | Deflection Front or Rear             | 0             | 0.051   | 0          | 1.0  |
| H4     | Feedhole to Bottom of Component      | 0.7086        | 0.768   | 18         | 19.5 |
| H5     | Feedhole to Seating Plane            | 0.610         | 0.649   | 15.5       | 16.5 |
| L      | Defective Unit Clipped Dimension     | 0.3346        | 0.433   | 8.5        | 11   |
| L1     | Lead Wire Enclosure                  | 0.09842       | –       | 2.5        | –    |
| P      | Feedhole Pitch                       | 0.4921        | 0.5079  | 12.5       | 12.9 |
| P1     | Feedhole Center to Center Lead       | 0.2342        | 0.2658  | 5.95       | 6.75 |
| P2     | First Lead Spacing Dimension         | 0.1397        | 0.1556  | 3.55       | 3.95 |
| T      | Adhesive Tape Thickness              | 0.06          | 0.08    | 0.15       | 0.20 |
| T1     | Overall Taped Package Thickness      | –             | 0.0567  | –          | 1.44 |
| T2     | Carrier Strip Thickness              | 0.014         | 0.027   | 0.35       | 0.65 |
| W      | Carrier Strip Width                  | 0.6889        | 0.7481  | 17.5       | 19   |
| W1     | Adhesive Tape Width                  | 0.2165        | 0.2841  | 5.5        | 6.3  |
| W2     | Adhesive Tape Position               | 0.0059        | 0.01968 | 0.15       | 0.5  |

- Maximum alignment deviation between leads not to be greater than 0.2 mm.
- Defective components shall be clipped from the carrier tape such that the remaining protrusion (L) does not exceed a maximum of 11 mm.
- Component lead to tape adhesion must meet the pull test requirements established in Figures 51, 52 and 53.
- Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- Hold down tape not to extend beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
- No more than 1 consecutive missing component is permitted.
- A tape trailer and leader, having at least three feed holes is required before the first and after the last component.
- Splices will not interfere with the sprocket feed holes.

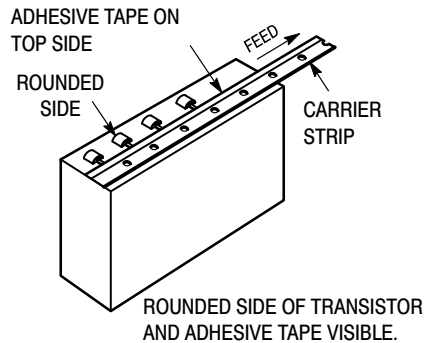
# TO-92 EIA RADIAL TAPE IN FAN FOLD BOX OR ON REEL

## FAN FOLD BOX STYLES



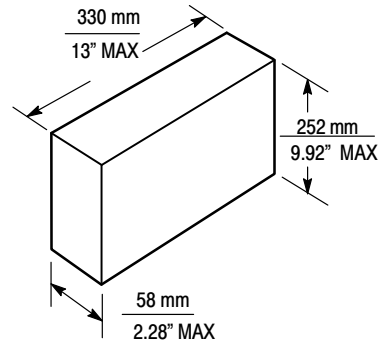
Style M fan fold box is equivalent to styles E and F of reel pack dependent on feed orientation from box.

**Figure 48. Style RLRM, RM**



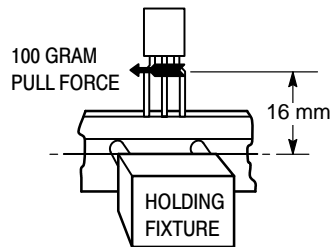
Style P fan fold box is equivalent to styles A and B of reel pack dependent on feed orientation from box.

**Figure 49. Style RLRP, RP**



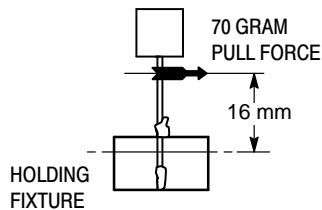
**Figure 50. Fan Fold Box Dimensions**

## ADHESION PULL TESTS



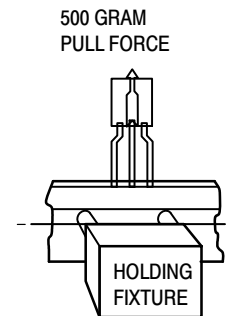
The component shall not pull free with a 300 gram load applied to the leads for  $3 \pm 1$  second.

**Figure 51. Test #1**



The component shall not pull free with a 70 gram load applied to the leads for  $3 \pm 1$  second.

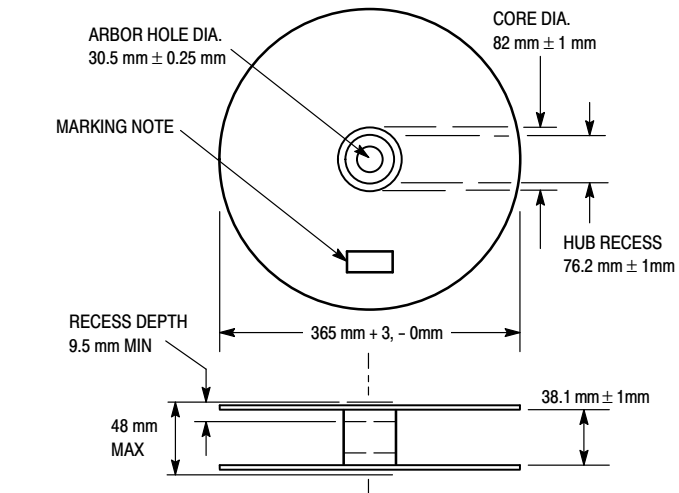
**Figure 52. Test #2**



There shall be no deviation in the leads and no component leads shall be pulled free of the tape with a 500 gram load applied to the component body for  $3 \pm 1$  second.

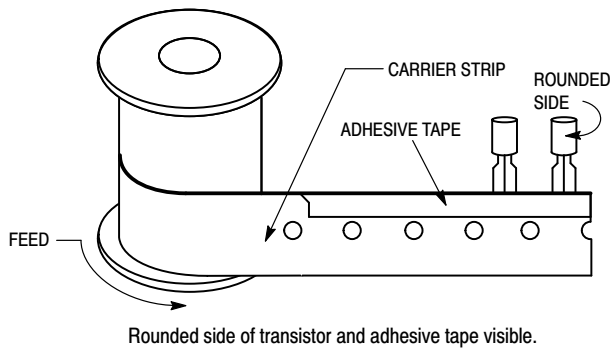
**Figure 53. Test #3**

# TO-92 EIA RADIAL TAPE IN FAN FOLD BOX OR ON REEL: REEL STYLES

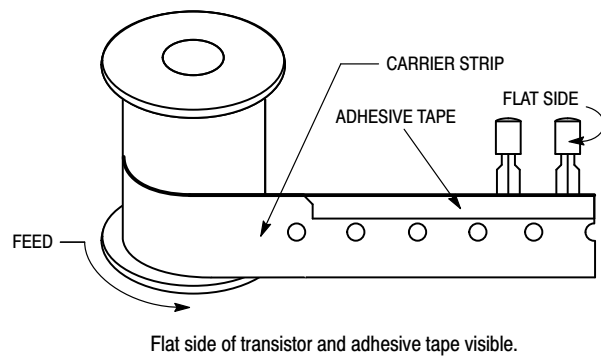


Material used must not cause deterioration of components or degrade lead solderability

**Figure 54. Reel Specifications**



**Figure 55. Style RLRA, RA**



**Figure 56. Style RLRE, RE**



# Lead Tape Packaging Standards for Axial-Lead Components

## 1.0 SCOPE

This section covers packaging requirements for the following axial-lead component's use in automatic testing and assembly equipment: ON Semiconductor Case 17-02, Case 41A-02, Case 51-02 (DO-7), Case 59-03 (DO-41), Case 59-04, Case 194-04 and Case 299-02 (DO-35). Packaging, as covered in this section, shall consist of axial-lead components mounted by their leads on pressure sensitive tape, wound onto a reel.

## 2.0 PURPOSE

This section establishes ON Semiconductor standard practices for lead-tape packaging of axial-lead components and meets the requirements of EIA Standard RS-296-D "Lead-taping of Components on Axial Lead Configuration for Automatic Insertion," level 1.

## 3.0 REQUIREMENTS

### 3.1 Component Leads

**3.1.1** – Component leads shall not be bent beyond dimension E from their normal position. See Figure 58.

**3.1.2** – The "C" dimension shall be governed by the overall length of the reel packaged component. The distance between flanges shall be 0.059 inch to 0.315 inch greater than the overall component length. See Figures 58 and 59.

**3.1.3** – Cumulative dimension "A" tolerance shall not exceed 0.059 over 6 in consecutive components.

### 3.2 Orientation

All polarized components must be oriented in one direction. The cathode lead tape shall be any color except white and the anode tape shall be white. See Figure 57.

### 3.3 Reeling

**3.3.1** – Components on any reel shall not represent more than two date codes when date code identification is required.

**3.3.2** – Component's leads shall be positioned perpendicularly between pairs of 0.250 inch tape. See Figure 58.

**3.3.3** – A minimum 12 inch leader of tape shall be provided before the first and last component on the reel.

**3.3.4** – 50 lb. Kraft paper is wound between layers of components as far as necessary for component protection.

**3.3.5** – Components shall be centered between tapes such that the difference between D1 and D2 does not exceed 0.055.

**3.3.6** – Staples shall not be used for splicing. No more than four layers of tape shall be used in any splice area and no tape shall be offset from another by more than 0.031 inch noncumulative. Tape splices shall overlap at least 6 inches for butt joints and at least 3 inches for lap joints and shall not be weaker than unspliced tape.

**3.3.7** – Quantity per reel shall be as indicated in Table 1. Orders for tape and reeled product will only be processed and shipped in full reel increments. Scheduled orders must be in releases of full reel increments or multiples thereof.

**3.3.8** – A maximum of 0.25% of the components per reel quantity may be missing without consecutive missing per level 1 of RS-296-D.

**3.3.9** – The single face roll pad shall be placed around the finished reel and taped securely. Each reel shall then be placed in an appropriate container.

## 3.4 Marking

Minimum reel and carton marking shall consist of the following (see Figure 59):

ON Semiconductor part number

Quantity

Manufacturer's name

Date codes (when applicable; see note **3.3.1**)

## 4.0

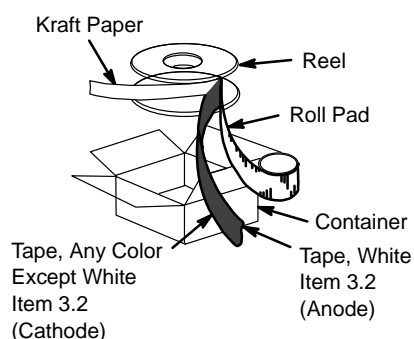
Requirements differing from this ON Semiconductor standard shall be negotiated with the factory.

The packages indicated in the following table are suitable for lead tape packaging. Table 1 indicates the specific devices (transient voltage suppressors and/or Zeners) that can be obtained from ON Semiconductor in reel packaging and provides the appropriate packaging specification.

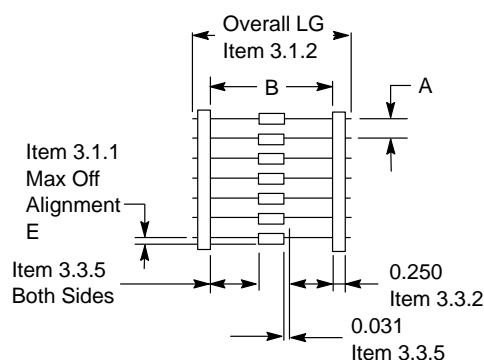
# Lead Tape Packaging Standards for Axial-Lead Components

**Table 1. PACKAGING DETAILS** (all dimensions in inches)

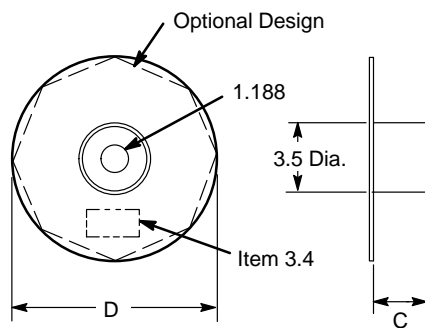
| Case Type | Product Category                           | Device Title Suffix | MPQ Quantity Per Reel | Component Spacing A Dimension | Tape Spacing B Dimension | Reel Dimension C | Reel Dimension D (Max) | Max Off Alignment E |
|-----------|--|---------------------|-----------------------|-------------------------------|--------------------------|------------------|------------------------|---------------------|
| Case 17   | Surmetic 40 & 600 Watt TVS                 | RL                  | 4000                  | $0.2 \pm 0.015$               | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |
| Case 41A  | 1500 Watt TVS                              | RL4                 | 1500                  | $0.4 \pm 0.02$                | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |
| Case 59   | DO-41 Glass & DO-41 Surmetic 30            | RL                  | 6000                  | $0.2 \pm 0.015$               | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |
|           | Rectifier                                  |                     |                       |                               |                          |                  |                        |                     |
| Case 59   | 500 Watt TVS                               | RL                  | 500                   | $0.2 \pm 0.02$                | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |
|           | Rectifier                                  |                     |                       |                               |                          |                  |                        |                     |
| Case 194  | 110 Amp TVS (Automotive)                   | RL                  | 800                   | $0.4 \pm 0.02$                | $1.875 \pm 0.059$        | 3                | 14                     | 0.047               |
|           | Rectifier                                  |                     |                       |                               |                          |                  |                        |                     |
| Case 267  | Rectifier                                  | RL                  | 1500                  | $0.4 \pm 0.02$                | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |
| Case 299  | DO-35 Glass                                | RL                  | 5000                  | $0.2 \pm 0.02$                | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |
| Case 267  | Schottky & Ultrafast Rectifiers            | RL                  | 1500                  | $0.4 \pm 0.02$                | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |
| Case 267  | Fast Recovery & General Purpose Rectifiers | RL                  | 1200                  | $0.4 \pm 0.02$                | $2.062 \pm 0.059$        | 3                | 14                     | 0.047               |



**Figure 57. Reel Packing**



**Figure 58. Component Spacing**



**Figure 59. Reel Dimensions** (Item references appear on Page 32)

## INFORMATION FOR USING SURFACE MOUNT PACKAGES

### RECOMMENDED FOOTPRINTS FOR SURFACE MOUNTED APPLICATIONS

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to ensure proper solder connection

interface between the board and the package. With the correct pad geometry, the packages will self align when subjected to a solder reflow process.

### POWER DISSIPATION FOR A SURFACE MOUNT DEVICE

The power dissipation for a surface mount device is a function of the drain/collector pad size. These can vary from the minimum pad size for soldering to a pad size given for maximum power dissipation. Power dissipation for a surface mount device is determined by  $T_{J(max)}$ , the maximum rated junction temperature of the die,  $R_{\theta JA}$ , the thermal resistance from the device junction to ambient, and the operating ambient temperature,  $T_A$ . Using the values provided on the data sheet,  $P_D$  can be calculated as follows:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

The values for the equation are found in the maximum ratings table on the data sheet. Substituting these values into the equation for an ambient temperature  $T_A$  of 25°C, one can calculate the power dissipation of the device. For example, for a SOT-223 device,  $P_D$  is calculated as follows.

$$P_D = \frac{150^\circ\text{C} - 25^\circ\text{C}}{156^\circ\text{C/W}} = 800 \text{ milliwatts}$$

The 156°C/W for the SOT-223 package assumes the use of the recommended footprint on a glass epoxy printed circuit board to achieve a power dissipation of 800 milliwatts. There are other alternatives to achieving higher power dissipation from the surface mount packages. One is to increase the area of the drain/collector pad. By increasing the area of the drain/collector pad, the power dissipation can be increased. Although the power dissipation can almost be doubled with this method, area is taken up on the printed circuit board which can defeat the purpose of using surface mount technology. For example, a graph of  $R_{\theta JA}$  versus drain pad area is shown in Figures 60, 61 and 62.

Another alternative would be to use a ceramic substrate or an aluminum core board such as Thermal Clad™. Using a board material such as Thermal Clad, an aluminum core board, the power dissipation can be doubled using the same footprint.

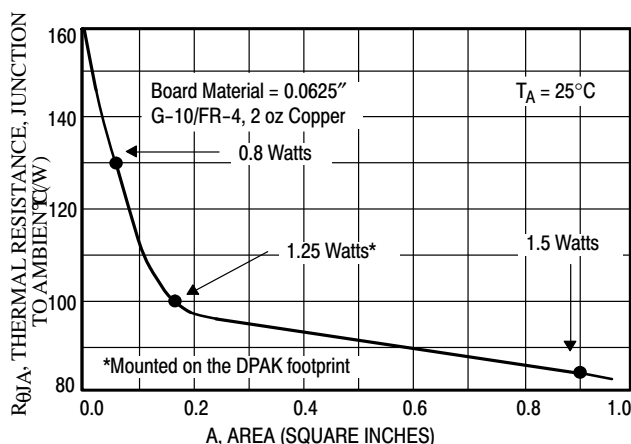


Figure 60. Thermal Resistance versus Drain Pad Area for the SOT-223 Package (Typical)

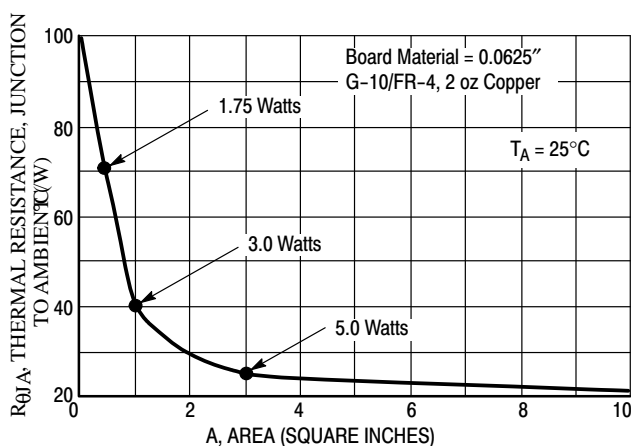
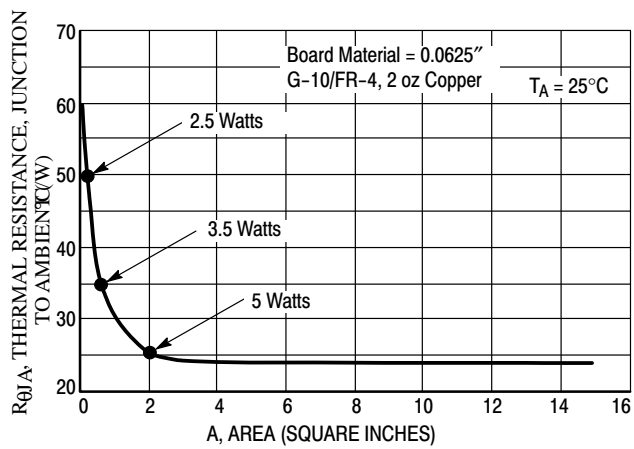


Figure 61. Thermal Resistance versus Drain Pad Area for the DPAK Package (Typical)



**Figure 62. Thermal Resistance versus Drain Pad Area for the D<sup>2</sup>PAK Package (Typical)**

## SOLDER STENCIL GUIDELINES

Prior to placing surface mount components onto a printed circuit board, solder paste must be applied to the pads. Solder stencils are used to screen the optimum amount. These stencils are typically 0.008 inches thick and may be made of brass or stainless steel. For packages such as the SC-59, SC-70/SOT-323, SOD-123, SOT-23, SOT-143, SOT-223, SO-8, SO-14, SO-16, and SMB/SMC diode packages, the stencil opening should be the same as the pad size or a 1:1 registration. This is not the case with the DPAK and D<sup>2</sup>PAK packages. If a 1:1 opening is used to screen solder onto the drain pad, misalignment and/or “tombstoning” may occur due to an excess of solder. For these two packages, the opening in the stencil for the paste should be approximately 50% of the tab area. The opening for the leads is still a 1:1 registration. Figure 63 shows a typical stencil for the DPAK and D<sup>2</sup>PAK packages. The

pattern of the opening in the stencil for the drain pad is not critical as long as it allows approximately 50% of the pad to be covered with paste.

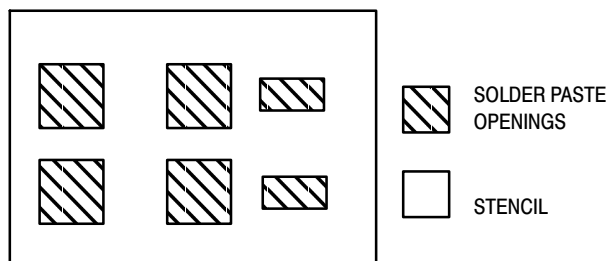


Figure 63. Typical Stencil for DPAK and D<sup>2</sup>PAK Packages

## SOLDERING PRECAUTIONS

The melting temperature of solder is higher than the rated temperature of the device. When the entire device is heated to a high temperature, failure to complete soldering within a short time could result in device failure. Therefore, the following items should always be observed in order to minimize the thermal stress to which the devices are subjected.

- Always preheat the device.
- The delta temperature between the preheat and soldering should be 100°C or less.\*
- When preheating and soldering, the temperature of the leads and the case must not exceed the maximum temperature ratings as shown on the data sheet. When using infrared heating with the reflow soldering method, the difference should be a maximum of 10°C.
- For wave soldering, the soldering temperature and time should not exceed 260°C for more than 10 seconds. For other reflow methods such as convection and IR ovens, refer to the reflow profiles on the following pages.

- When shifting from preheating to soldering, the maximum temperature gradient shall be 5°C or less.
- After soldering has been completed, the device should be allowed to cool naturally for at least three minutes. Gradual cooling should be used since the use of forced cooling will increase the temperature gradient and will result in latent failure due to mechanical stress.
- Mechanical stress or shock should not be applied during cooling.

\* Soldering a device without preheating can cause excessive thermal shock and stress which can result in damage to the device.

\* Due to shadowing and the inability to set the wave height to incorporate other surface mount components, the D<sup>2</sup>PAK is not recommended for wave soldering.

## TYPICAL SOLDER HEATING PROFILE

For any given circuit board, there will be a group of control settings that will give the desired heat pattern. The operator must set temperatures for several heating zones and a figure for belt speed. Taken together, these control settings make up a heating “profile” for that particular circuit board. On machines controlled by a computer, the computer remembers these profiles from one operating session to the next. Figure 64 shows a typical heating profile for use when soldering a surface mount device to a printed circuit board. This profile will vary among soldering systems, but it is a good starting point. Factors that can affect the profile include the type of soldering system in use, density and types of components on the board, type of solder used, and the type of board or substrate material being used. This profile shows temperature versus time. The line on the graph shows the

actual temperature that might be experienced on the surface of a test board at or near a central solder joint. The two profiles are based on a high density and a low density board. The Vitronics SMD310 convection/infrared reflow soldering system was used to generate this profile. The type of solder used was 62/36/2 Tin Lead Silver with a melting point between 177–189°C. When this type of furnace is used for solder reflow work, the circuit boards and solder joints tend to heat first. The components on the board are then heated by conduction. The circuit board, because it has a large surface area, absorbs the thermal energy more efficiently, then distributes this energy to the components. Because of this effect, the main body of a component may be up to 30 degrees cooler than the adjacent solder joints.

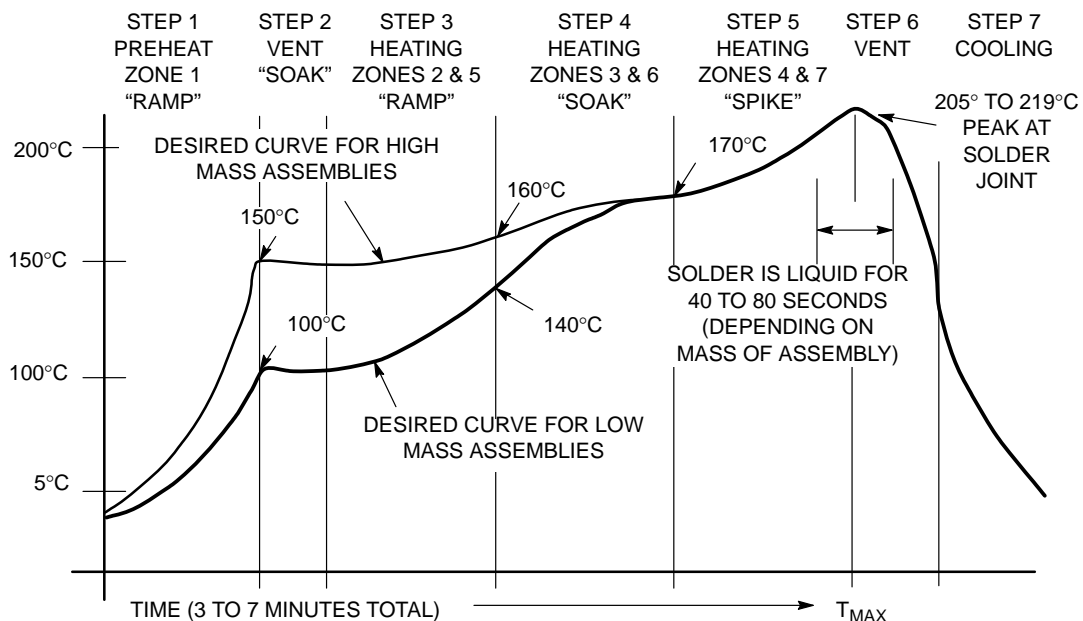
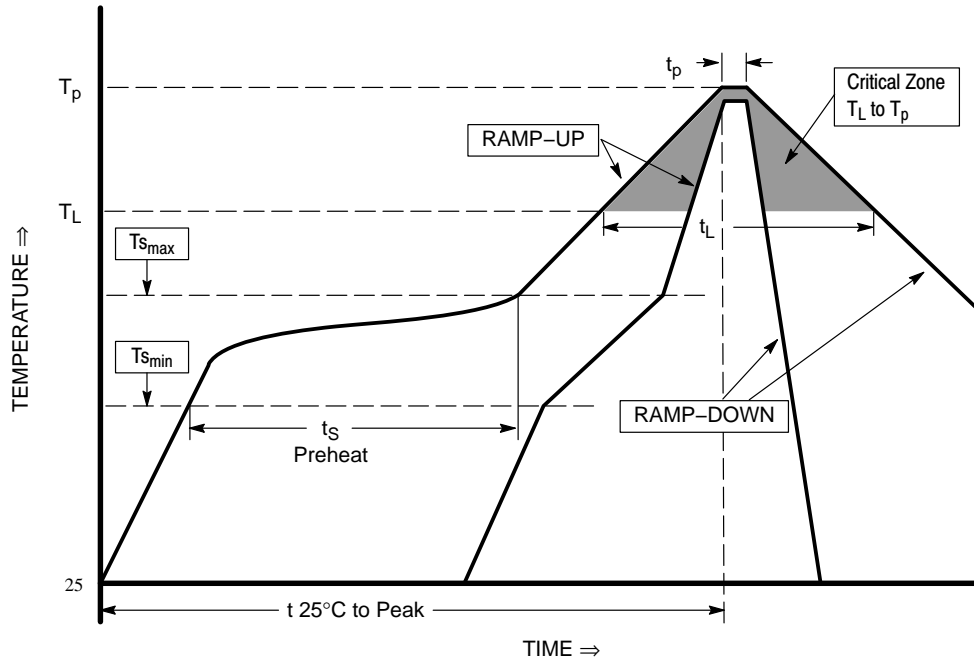


Figure 64. Typical Tin Lead (SnPb) Solder Heating Profile

## TYPICAL SOLDER HEATING PROFILE (continued)



**Figure 65. Typical Pb-Free Solder Heating Profile**

| Profile Feature  | Pb-Free Assembly                 |
|--|----------------------------------|
| Average Ramp-Up Rate ( $T_{s_{max}}$ to $T_p$ )  | 3°C/second max                   |
| Preheat<br>Temperature Min ( $T_{s_{min}}$ )<br>Temperature Max ( $T_{s_{max}}$ )<br>Time ( $t_{s_{min}}$ to $t_{s_{max}}$ ) | 150°C<br>200°C<br>60–180 seconds |
| Time maintained above<br>Temperature ( $T_T$ )<br>Time ( $t_T$ )   | 217°C<br>60–150 seconds          |
| Peak Classification Temperature ( $T_p$ )  | 260°C +5/-0                      |
| Time within 5°C of actual Peak Temperature ( $t_p$ )   | 20–40 seconds                    |
| Ramp-Down Rate   | 6°C/second max                   |
| Time 25°C to Peak Temperature  | 8 minutes max                    |

## AMBIENT MOUNTING DATA

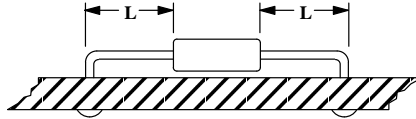
Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

| Mounting Method |                 | Lead Length, L (IN) |     |     |     | Units                |
|-----------------|-----------------|---------------------|-----|-----|-----|----------------------|
|                 |                 | 1/8                 | 1/4 | 1/2 | 3/4 |                      |
| 1               | $R_{\theta JA}$ | 50                  | 51  | 53  | 55  | $^{\circ}\text{C/W}$ |
| 2               |                 | 58                  | 59  | 61  | 63  | $^{\circ}\text{C/W}$ |
| 3               |                 | 28                  |     |     |     | $^{\circ}\text{C/W}$ |

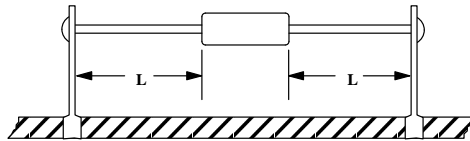
#### MOUNTING METHOD 1

P.C. Board Where Available Copper Surface area is small.



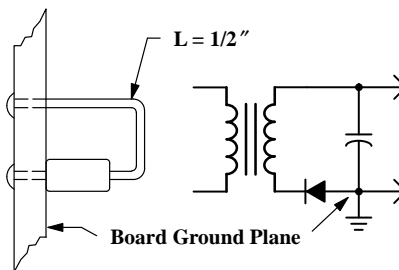
#### MOUNTING METHOD 2

Vector Push-In Terminals T-28



#### MOUNTING METHOD 3

P.C. Board with  
1-1/2" x 1-1/2" Copper Surface





# Humidity Indicator Card: Type HIC-0560

## Objective

The objective of this information brief is to provide the customer with a general understanding of the humidity indicator cards (HIC) basic functions and a reaction plan based on the level of dryness as indicated on the card.

## Introduction

The HIC is printed with moisture sensitive spots which will respond to variations of different levels of humidity with perceptible change in color typically from blue (dry) to pink (wet). The HIC is packed inside moisture barrier bags, which monitor the moisture inside the barrier bag. When the bag is opened, the HIC can be examined to determine the degree of dryness of the parts inside the bag.

## Humidity Indicator Cards: HIC-0515 and HIC-0560

Excess humidity in the dry pack is noted by the HIC. It can occur due to misprocessing (e.g. missing or inadequate desiccant), mishandling (e.g. tears or rips in the moisture barrier bag) or improper storage.

The HIC should be read immediately upon removal from the moisture barrier bag. For best accuracy, the HIC should be read at  $23\pm5^{\circ}\text{C}$ . The following conditions apply regardless of the storage time (whether or not the shelf life has exceeded).

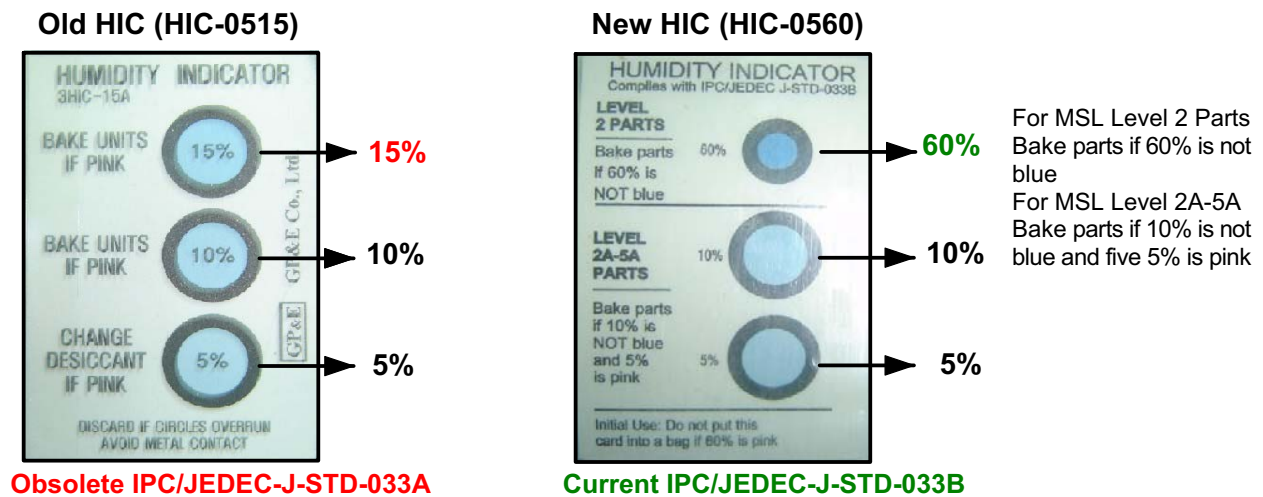


Figure 66. Humidity Indicator Card

Table 2: HIC Conditions and Corresponding Actions for HIC-0560

| HIC Conditions | 5%   | 10%  | 60%  | Action                          | Remarks  |
|----------------|------|------|------|---------------------------------|--|
| Condition 1    | Blue | Blue | Blue | No bake                         | Parts are dry  |
| Condition 2    | Pink | Blue | Blue | No bake                         | Only indicates that parts have 5% level of moisture                      |
| Condition 3    | Pink | Pink | Blue | Bake required, refer to Table 2 | Bake parts MSL levels 2a, 3, 4, 5, and 5a<br>No need to bake MSL level 2 |
| Condition 4    | Pink | Pink | Pink | Bake required, refer to Table 2 | All were parts were affected by moisture                                 |

### Bake Duration for Exposed Parts

AMIS recommends that bake duration of exposed parts should comply with the existing provisions as mandated by Joint Industry Standard IPC/JEDEC-STD-033B entitled

“Handling, Packing and Use of Moisture/Reflow Sensitive Surface Mount Devices” Bake Duration for Exposed Parts as shown in Table 3.

**Table 3: Reference Conditions for Drying Mounted or Unmounted SMD Packages**  
(User bake: floor life begins counting at time = 0 after bake)

| Package Body   | Level | Bake @ 125°C                   |   | Bake @ 90°C<br>≤ 5% RH         |   | Bake @ 40°C<br>≤ 5% RH         |   |
|--|-------|--------------------------------|---|--------------------------------|---|--------------------------------|---|
|  |       | Exceeding Floor Life by > 72 h | Exceeding Floor Life by > 72 h                    | Exceeding Floor Life by > 72 h | Exceeding Floor Life by > 72 h                    | Exceeding Floor Life by > 72 h | Exceeding Floor Life by > 72 h                    |
| Thickness ≤ 1.4mm  | 2     | 5 hours                        | 3 hours   | 17 hours                       | 11 hours  | 8 days                         | 5 days  |
|  | 2a    | 7 hours                        | 5 hours   | 23 hours                       | 13 hours  | 9 days                         | 7 days  |
|  | 3     | 9 hours                        | 7 hours   | 33 hours                       | 23 hours  | 13 days                        | 9 days  |
|  | 4     | 11 hours                       | 7 hours   | 37 hours                       | 23 hours  | 15 days                        | 9 days  |
|  | 5     | 12 hours                       | 7 hours   | 41 hours                       | 24 hours  | 17 days                        | 10 days   |
|  | 5a    | 16 hours                       | 10 hours  | 54 hours                       | 24 hours  | 22 days                        | 10 days   |
| Thickness > 1.4mm ≤ 2.0mm                                      | 2     | 18 hours                       | 15 hours  | 63 hours                       | 2 days  | 25 days                        | 20 days   |
|  | 2a    | 21 hours                       | 16 hours  | 3 days                         | 2 days  | 29 days                        | 22 days   |
|  | 3     | 27 hours                       | 17 hours  | 4 days                         | 2 days  | 37 days                        | 23 days   |
|  | 4     | 34 hours                       | 20 hours  | 5 days                         | 3 days  | 47 days                        | 28 days   |
|  | 5     | 40 hours                       | 25 hours  | 6 days                         | 4 days  | 57 days                        | 35 days   |
|  | 5a    | 48 hours                       | 40 hours  | 8 days                         | 6 days  | 79 days                        | 56 days   |
| Thickness > 2.0mm ≤ 4.5mm                                      | 2     | 48 hours                       | 48 hours  | 10 days                        | 7 days  | 79 days                        | 67 days   |
|  | 2a    | 48 hours                       | 48 hours  | 10 days                        | 7 days  | 79 days                        | 67 days   |
|  | 3     | 48 hours                       | 48 hours  | 10 days                        | 8 days  | 79 days                        | 67 days   |
|  | 4     | 48 hours                       | 48 hours  | 10 days                        | 10 days   | 79 days                        | 67 days   |
|  | 5     | 48 hours                       | 48 hours  | 10 days                        | 10 days   | 79 days                        | 67 days   |
|  | 5a    | 48 hours                       | 48 hours  | 10 days                        | 10 days   | 79 days                        | 67 days   |
| BGA package > 17mm x 17mm or any stacked die package (Note 12) | 2-6   | 96 hours                       | As above per package thickness and moisture level | Not applicable                 | As above per package thickness and moisture level | Not applicable                 | As above per package thickness and moisture level |

**NOTES:**

11. Table 3 is based on worst-case molded lead frame SMD packages. Users may reduce the actual back time if technically justified (e.g. absorption/desorption data, etc.). In most cases it is applicable to other nonhermetic surface mount SMD packages.
12. For BGA packages > 17mm x >17 mm that do not have internal planes that block the moisture diffusion path in the substrate they may use bake times based on the thickness/moisture level portion of the table.

## Sales and Design Assistance from ON Semiconductor

ON Semiconductor Technical Support  
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| FRANCE                                       | Paris          | 33 (0)1 39-26-41-00 |
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|                |                     |                            |                    |
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| Alabama        | Huntsville          | e-Components               | (256) 533-2444     |
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| California     | Bay Area            | Electec                    | (408) 496-0706     |
|                | Southern California | Tech Coast Sales           | (949) 305-6869     |
| Canada         | Eastern Canada      | Astec                      | (905) 607-1444     |
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| Florida        | Statewide           | e-Components               | (888) 468-2444     |
| Georgia        | Atlanta             | e-Components               | (888) 468-2444     |
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| Indiana        | Fishers             | Bear VAI                   | (317) 570-0707     |
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| Michigan       | St. Joseph          | Bear VAI                   | (440) 526-1991     |
| Minnesota      | Eden Prairie        | Matrix – Design Technology | (952) 400-1070     |
| Missouri       | Belton              | Matrix – Design Technology | (816) 589-2308     |
| Nebraska       | Statewide           | Matrix – Design Technology | (816) 589-2308     |
| New Hampshire  | Statewide           | Paragon Electronic Systems | (603) 645-7630     |
| New Jersey     | Statewide           | S.J. Metro                 | (516) 942-3232     |
| New York       | Binghamton          | TriTech – Full Line Rep    | (607) 722-3580     |
|                | Jericho             | S.J. Metro                 | (516) 942-3232     |
|                | Rochester           | TriTech – Full Line Rep    | (585) 385-6500     |
| North Carolina | Raleigh             | e-Components               | (888) 468-2444     |
| North Dakota   | Statewide           | Matrix – Design Technology | (952) 400-1070     |
| Ohio           | Brecksville         | Bear VAI Technology        | (440) 526-1991     |
| Puerto Rico    | Countrywide         | e-Components               | (888) 468-2444     |
| Rhode Island   | Statewide           | Paragon Electronic Systems | (603) 645-7630     |
| South Dakota   | Statewide           | Matrix – Design Technology | (952) 400-1070     |
| Vermont        | Statewide           | Paragon Electronic Systems | (603) 645-7630     |
| Wisconsin      | Statewide           | Matrix – Design Technology | (952) 400-1070     |

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| Altima Corp.                       | <a href="http://www.ultima.co.jp">www.ultima.co.jp</a>                                   | (81) 45 476 2155  |
| Arrow Electronics                  | <a href="http://www.arrow.com">www.arrow.com</a>   | (800) 777-2776  |
| Avnet                              | <a href="http://www.em.avnet.com">www.em.avnet.com</a>                                   | (800) 332-8638  |
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